DENON

Hi-Fi Component

SERVICE MANUAL MODEL DN-2000F

DOUBLE CD PLAYER



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NIPPON COLUMBIA CO., LTD.

IMPORTANT TO SAFETY

WARNING:

TO PREVENT FIRE OR SHOCK HAZARD, DO NOT EXPOSE THIS APPLIANCE TO RAIN OR MOISTURE.

CAUTION:

1. Handle the power supply cord carefully

Do not damage or deform the power supply cord. If it is damaged or deformed, it may cause electric shock or malfunction when used. When removing from wall outlet, be sure to remove by holding the plug attachment and not by pulling the cord.

2. Do not open the top cover

In order to prevent electric shock, do not open the top cover. If problems occur, contact your DENON dealer.

3. Do not place anything inside

Do not place metal objects or spill liquid inside the CD player. Electric shock or malfunction may result.

Please, record and retain the Model name and serial number of your set shown on the rating label.

Model No. DN-2000F

Serial No.



CAUTION

RISK OF ELECTRIC SHOCK
DO NOT OPEN



CAUTION: TO REDUCE THE RISK OF ELECTRIC SHOCK, DO NOT REMOVE COVER (OR BACK). NO USER-SERVICEABLE PARTS INSIDE. REFER SERVICING TO QUALIFIED SERVICE PERSONNEL.



The lightning flash with arrowhead symbol, within an equilateral triangle, is intended to alert the user to the presence of uninsulated "dangerous voltage" within the product's enclosure that may be of sufficient magnitude to constitute a risk of electric shock to persons.



The exclamation point within an equilateral triangle is intended to alert the user to the presence of important operating and maintenance (servicing) instructions in the literature accompanying the appliance.

IMPORTANT (BRITISH MODEL ONLY)

The wires in this mains lead are coloured in accordance with the following code:

Blue: Neutral

Brown: Live

The colours of the wires in the mains lead of this apparatus may not correspond with the coloured markings identifying the terminals in your plug proceed as follows.

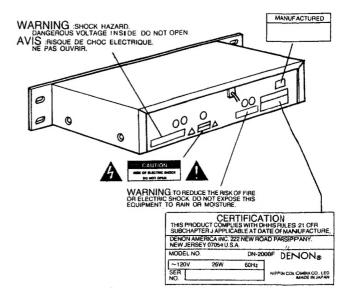
The wire which is coloured blue must be connected to the terminal which is marked with the letter N or coloured black.

The wire which is coloured brown must be connected to the terminal which is marked with the letter L or coloured red.

NOTE

This CD player uses the semiconductor laser. To allow you to enjoy music at a stable operation, it is recommended to use this in a room of 5° C (41°F) – 35°C (95°F).

LABELS (for U.S.A. model only)



CAUTION

USE OF CONTROLS OR ADJUSTMENTS OR REFORMANCE OF PROCE-DURES OTHER THAN THOSE SPECIFIED HEREIN MAY RESULT IN HAZARDOUS RADIATION EXPOSURE.

THE COMPACT DISC PLAYER SHOULD NOT BE ADJUSTED OR REPAIRED BY ANYONE EXCEPT PROPERLY QUALIFIED SERVICE PERSONNEL.

NOTE:

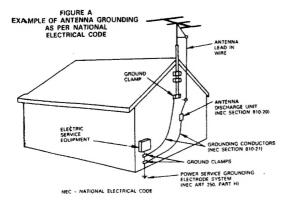
This unit may cause interference to radio and television reception if you do not operate it in strict accordance with this OPERATING INSTRUCTIONS.

This unit complies with Class B computing device rules in accordance with the specifications in Sub-part J or Part 15 of the FCC Rules, which are designed to provide reasonable protection against such interference in a residential installation. If the unit does cause interference to any radio or television reception, try to reduce it by one or more of the following means:

- a) Turn the other unit to improve reception
- b) Move this unit
- c) Move this unit away from others
- d) Plug this unit respectively into a different AC outlet
- * This is note in accordance with Section 15.838 of the FC Pules.

SAFETY INSTRUCTIONS

- Read Instructions All the safety and operating instructions should be read before the appliance is operated.
- Retain Instructions The safety and operating instructions should be retained for future reference.
- Heed Warnings All warnings on the appliance and in the operating instructions should be adhered to.
- Follow Instructions All operating and use instructions should be followed.
- Water and Moisture The appliance should not be used near water – for example, near a bathtub, washbowl, kitchen sink, laundry tub, in a wet basement, or near a swimming pool, and the like.
- Carts and Stands The appliance should be used only with a cart or stand that is recommended by the manufacturer.
- 6A. An appliance and cart combination should be moved with care. Quick stops, excessive force, and uneven surfaces may cause the appliance and cart combination to overturn.
- Wall or Ceiling Mounting The appliance should be mounted to a wall or ceiling only as recommended by the manufacturer.
- 8. Ventilation The appliance should be situated so that its location or position does not interfere with its proper ventilation. For example, the appliance should not be situated on a bed, sofa, rug, or similar surface that may block the ventilation openings; or, placed in a built-in installation, such as a bookcase or cabinet that may impede the flow of air through the ventilation openings.
- Heat The appliance should be situated away from heat sources such as radiators, heat registers, stoves, or other appliances (including amplifiers) that produce heat.
- Power Sources The appliance should be connected to a power supply only of the type described in the operating instructions or as marked on the appliance.
- Grounding or Polarization The precautions that should be taken so that the grounding or polarization means of an appliance is not defeated.



- 12. Power-Cord Protection Power-supply cords should be routed so that they are not likely to be walked on or pinched by items placed upon or against them, paying particular attention to cords at plugs, convenience receptacles, and the point where they exit from the appliance.
- Cleaning The appliance should be cleaned only as recommended by the manufacturer.
- Power Lines An outdoor antenna should be located away from power lines.
- 15. Outdoor Antenna Grounding If an outside antenna is connected to the receiver, be sure the antenna system is grounded so as to provide some protection against voltage surges and built up static charges. Section 810 of the National Electrical Code, ANSI/NFPA No. 70–1984, provides information with respect to proper grounding of the mast and supporting structure, grounding of the lead-in wire to an antenna discharge unit, size of grounding conductors, location of antenna-discharge unit, connection to grounding electrodes, and requirements for the grounding electrode. See Figure A.
- Nonuse Periods The power cord of the appliance should be unplugged from the outlet when left unused for a long period of time.
- Object and Liquid Entry Care should be taken so that objects do not fall and liquids are not spilled into the enclosure through openings.
- Damage Requiring Service The appliance should be serviced by qualified service personnel when:
 - A. The power-supply cord or the plug has been damaged; or
 - B. Objects have fallen, or liquid has been spilled into the appliance; or
 - C. The appliance has been exposed to rain; or
 - D. The appliance does not appear to operate normally or exhibits a marked change in performance; or
 - E. The appliance has been dropped, or the enclosure damaged.
- Servicing The user should not attempt to service the appliance beyond that described in the operating instructions. All other servicing should be referred to qualified service personnel.

NOTE ON USE/HINWEISE ZUM GEBRAUCH/OBSERVATIONS RELATIVES A L'UTILISATION NOTE SULL'USO/NOTAS SOBRE EL USO/ALVORENS TE GEBRUIKEN/OBSERVERA OBSERVAÇÕES QUANTO AO USO



- Avoid high temperatures
 Allow for sufficient heat dispersion when installed on a rack. Vermeiden Sie hohe Temperaturen
- Beachten Sie, daß eine zureichende Luftzir-kulation gewährleistet wird, wenn das Gerät auf ein Regal gestellt wird. Eviter des températures élevées
- Tenir comote d'une dispersion de chaleur suffisante lors de l'installation sur une étagère. Evitate di esporre l'unità a temperature
- Assicuratevi che ci sia un'adequata disper sione del calore quando installate l'unità in
- un mobile per componenti audio. Evite altas temperaturas

 Permite la suficiente dispersión del calor cuando está instalado en la consola.
- Vermiid hoge temperaturen Zorg voor een degelijk hitteefvoer indien
- het apparaat op een rek wordt geplaatst. Undvik höga temperaturer. Se till att det finns möjlighet till god armeavledning vid montering i ett rack.
- Evite temperaturas altas Conceda suficiente dispersão de calor quando o equipamento for instalado numa



- Handle the power cord carefully.
- Hold the plug when unplugging the cord. Gehen Sie vorsichtig mit dem Netzkabel
- Halten Sie das Kabel am Stecker, wenn Sie den Stecker herausziehen. Manipuler le cordon d'alimentation avec
- précaution. Tenir la prise lors du débranchement du
- Manneggiate il filo di alimentazione con
- Agite per la spina quando scollegate il cavo dalla presa.
- Maneje el cordón de energia con cuidado. Sostenga el enchufe cuando desconecte el cordón de energía. Hanteer het netsnoer voorzichtig.
- Houd het snoer bij de stekker vast wanneer deze moet worden aan- of losgekoppeld. Hanters nätkebeln varsamt.
- Håll i kaboln när den kopplas från el-
- Manuseis com cuidado o fio condutor de



- . Keep the set free from moisture, water, and
- dust. Halten Sie das Gerät von Feuchtigkeit. Wasser und Staub fern
- Protéger l'appareil contre l'humidité l'esu et la poussière.

 Tenete l'unità iontana dall'umidità, dall'ac-
- qua e dalla poivere. Mantenga el equipo libre de humedad,
- agua y polvo.
 Last geen vochtigheid, water of stof in het
- Utsätt inte apparaten för fukt, vetten och
- Mantenha o aparelho livre de qualquer umidade, água ou poeira.



- Unplug the power cord when not using the set for long periods of time.
 Wann das Gerät eine längere Zeit nicht verwendet werden soll, trennen Sie das
- Netzkabai vom Natzsteckar.
- que l'appareil n'est pas utilisé pendant de
- longues périodes. Disinnestate il filo di alimentazione quando avete l'intenzione di non usare il filo di alimentazione per un lungo periodo di
- tempo. Desconecte el cordón de energía cuando no utilice el equipa por mucho tiempo. Neem altijd het netsnoer uit het stopkon-
- takt wanneer het apparaat gedurende een lange periode niet wordt gebruikt.
- Koppia ur nätkabeln om apparaten inte kommer att användas i lång tid.
- Desligue o fio condutor de força quando o aparelho não tiver que ser usado por um tongo periodo



- Do not obstruct the ventilation holes Die Belüftungsöffnungen dürfen nicht verdeckt werden.
- Ne pas obstruer les trous d'aération.
- Non coprite i fori di ventilazione.
- De ventilatieopeningen mogen niet worder
- Tapp inte till ventilationsoppningarna.
 Tapp inte till ventilationsoppningarna.



- Do not let foreign objects in the set Keine fremden Gegenstände in das Gerät kommen lassen.
- Ne pas laisser des obiets étrangers dans l'appareil.
- . E' importante che nessun oggetto è inserito all'interno dell'unità.
- No deje objetos extraños dentro del
- Last geen vreemde voorwerpen in dit Se till att främmunde föremål inte tränger
- in i apparaten.

 Não deixe objetos estrenhos no aparelho.



- Do not let insecticides, benzene, and thin-
- Lassen Sie das Gerat nicht mit Insektiziden Benzin oder Verdünnungsmitteln in Berührung kommen.
- Ne pas mettre en contact des insecticides, du benzène et un diluant avec l'appareil.
- Assicuratevvi che l'unità non venga in contatto con insetticidi, benzolo o soiventi. No permita el contacto de insecticidas gesolina y diluyantes con el equipo.
- Last geen insektenverdelgende middelen, benzine of verfverdunner met dit apparaat kontakt komen. Se till att inte insektsmedel på spraybruk
- bensen och thinner kommer i kontakt med apparatens hölja.
- Não permita que inseticidas, benzina e aparelho.



- Versuchen Sie niemals das Gerät auseinander zu nehmen oder auf jegliche Art zu
- Ne jamais démonter ou modifier l'appareil d'une manière ou d'une autre. Non smontate mai, nè modificate l'unità in
- nessun modo. Nunca desarme o modifique el equipo de

ninguna manera.

- Nooit dit apparant demonteren of op andere wijze modifiěren
- Ta inte isar apparaten och försök inte
- bygge om den.
 Nunca desmonte ou modifique a aparalhe
 de alguma forma.

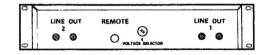
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. Line Voltage Selection (for multiple voltage model only)

- * The desired voltage may be set with the VOLTAGE SELECTOR knob on the rear panel, using a screwdriver.
- * Do not twist the VOLTAGE SELECTOR knob with excessive force as this may
- * If the VOLTAGE SELECTOR knob does not turn smoothly, please contact a qualified serviceman.





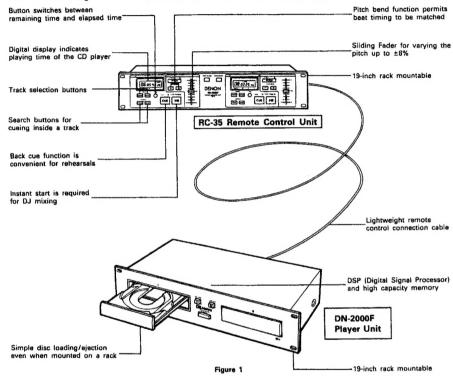
CAUTION:

Whenever the power switch is in the OFF state, the apparatus is still connected on AC line voltage. Please be sure to unplug the cord when you leave home for, say, a vacation.

Be sure turn on POWER switch after a Remote cable of RC-35 is connected to the Player unit, otherwise, the apparatus may not work correctly.

Main Features

The DN-2000F is a double CD player which provides excellent performance as well as a variety of functions ideal for DJ mixing. The unit can be mounted in a standard 19-inch rack.



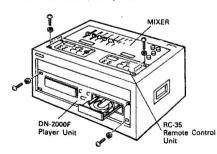
2 PREPARATION

(1) Check the Contents

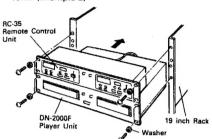
screws

(2) Install the Units

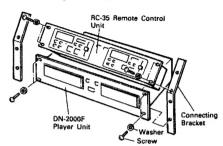
Mount the units onto the DJ console with 19"
 EiA rack rails. (Example-1)

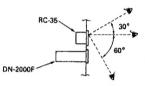


② Mount the units onto the rack with 19" EIA rack rails. (Example-2)



3 To operate the units on the desk top, use the connecting brackets provided.

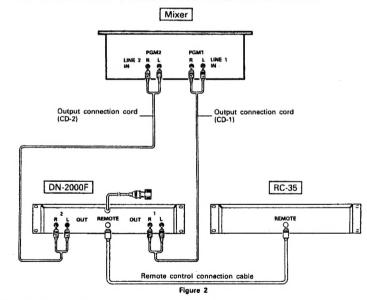




Install the RC-35 to a rack so as to maintain an appropriate visual angle to read the display as shown here.

(3) Connections

Typical connections with a mixer is illustrated below. Please use it for reference.

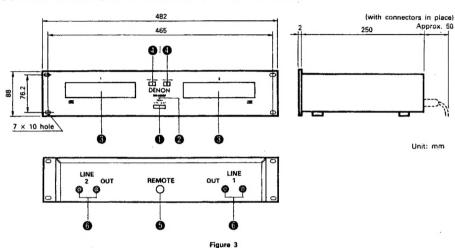


- Connect the connection cords to the line inputs of your mixer.
- The connection cords and the remote control connection cable are supplied with the main unit.
- Be sure to use the remote control connection cable which has been supplied. Use of another cable type might cause damage.

DESCRIPTION OF THE FUNCTIONS

Below is a description of the names of the various parts and the functions of the main unit.

(1) Names, Dimensions, and Functions of the Parts of the Main Unit



POWER (Power Switch)

Switches the power of the main unit and the remote control on and off. Power indicator 2 is lit when the power is on.

2 POWER (Power Indicator)

Lights up red when power switch is on.

Disc Holder

The disc is placed on this holder. Pressing the disc holder open/close buttons (1) will open and close each of the holders.

When loading the CD, place it securely in the disc holder.

OPEN/CLOSE (Disc Holder Open/Close Button) Press to load or eject the disc. Each press will open or close the disc holder 6.

The remote control is also equipped with similar buttons.

6 REMOTE (Remote Control Connector)

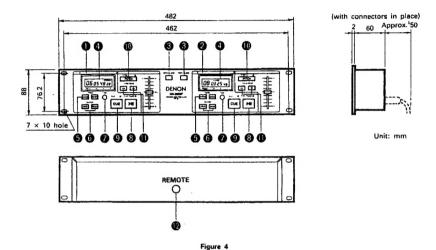
This connector accepts the cable which connects to the remote control unit RC-35. Insert the plug securely as far as it will advance.

6 LINE OUT (Output Jacks)

The audio from each CD player is output from these jacks.

Connect to the line input of the mixer. Red is for the right channel and white, the left channel.

(2) Names, Dimensions, and Functions of the Parts of the Remote Control Unit



CD-1 Remote Control Operation Panel

This operation panel remotely controls the main unit CD-1.

2 CD-2 Remote Control Operation Panel

This operation panel remotely controls the main unit

3 OPEN/CLOSE (Disc Holder Open/Close Button)

Press to load or eject the disc. Each press will open or close the disc holder 6.

@ Time Display

This display shows the track number, time (minutes, seconds and frames), and elapsed or remaining time. Each frame represents 1/75 of a second.

TRACK (Track Button)

This button selects the track to be played.

6 SEARCH (Search Buttons)

These buttons are used to accurately change the positions where disc play will start.

TIME (Time Button)

The TIME button switches the time display between elapsed time and remaining time. ELAPSE or REMAIN will be shown on the display.

@ PLAY/PAUSE (Play/Pause Button)

Each press of the PLAY/PAUSE button causes the operation to change from play to pause or from pause

O CUE (Cue Button)

Pressing the CUE button during play provides a return

to the position at which play was started. Alternately pressing the PLAY/PAUSE button and the CUE button allows the CD to be played from the same position any number of times.

The red CUE LED will blink from the time the CUE button is pressed until the CD has reset to the position at which play was started. Steady lighting of this LED indicates the ready condition.

PITCH (Pitch Button)

This button changes the play speed.

The pitch can be changed up to ±8% by pressing the PITCH button so the green PITCH LED is lit, then moving the sliding fader.

The pitch will not be changed if the green PITCH LED is off.

PITCH BEND (Pitch Bend Button)

When each of the two CD players are playing a CD, the pitch bend function allows the positioning of the bass beats to be matched after the pitch has been matched. The pitch will automatically rise while the + button is pressed and return to the original pitch when the button is released.

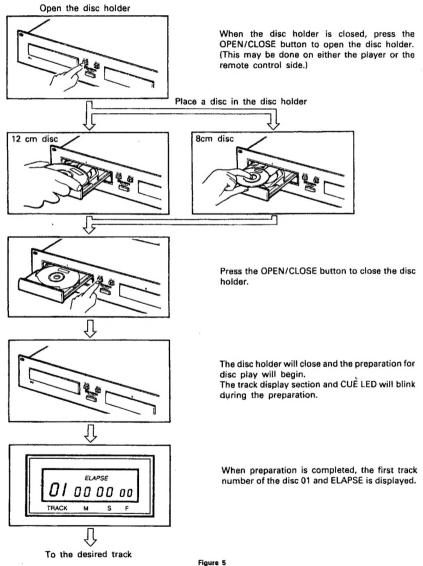
The pitch will drop while the - button is pressed. By changing the pitch in this way, the positioning of the beats can be matched.

REMOTE (Remote Control Connector)

This connector accepts the cable which connects to the main unit. Insert the plug securely as possible,

4 BASIC OPERATION

(1) Loading and Ejecting the Disc



(2) Selecting Tracks and play mode

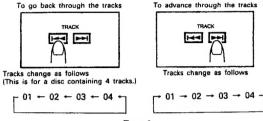


Figure 6

Each press of the TRACK button changes 1 track.

Continuing to hold the TRACK button down provides an automatic change at a higher speed which is convenient for discs that contain many tracks.

During the track selection operation, the track indication of the display will blink and the M S F indication will be off.

When a new track is selected during play, after the selection operation is completed, play will immediately start from the beginning of the newly selected track.

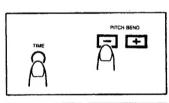
The track number can be selected before loading a disc on the player unit.

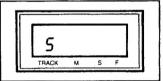
You can select a track to play on the controller, then load a disc. The player will cue up to your selected track automatically.

SINGLE/CONTINUE play mode selection

• Press the TIME and - buttons of PITCH BEND simultaneously to set the player for SINGLE track playback mode, "5" is displayed on TRACK section.

During single playback mode, the player stops after a specified track is played back.

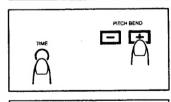


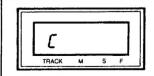


• Press the TIME and + button of PITCH BEND simultaneously to set the player for continuous playback mode, "[" is displayed on TRACK section.

During continuous playback mode, the player continue playback until completion of playback of the last track on the disc.

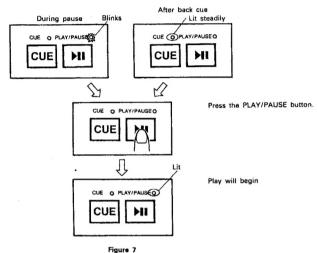
· When the power switch to ON, the player automatically set to CONTINUE playback mode.





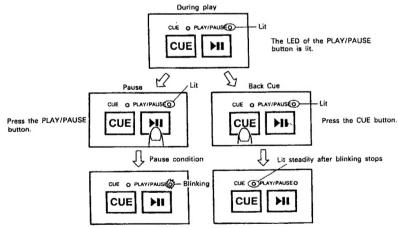
(3) Starting Play

Pressing the PLAY/PAUSE button during the pause condition or after the completion of back cue will start disc play.



(4) Stopping Play

There are two ways of stopping play. One uses the pause function and the other the back cue function.



The LED of the PLAY/PAUSE button blinks. (The CD pauses at the position where the PLAY/PAUSE button was pressed during play.

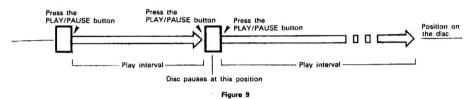
Back cue operation.
First the LED of the CUE button blinks, then it lights steadily after the operation is completed.
(The CD returns to the position where the disc was started from.)

(5) Description of the PLAY/PAUSE, and CUE Operations

- Each press of the PLAY/PAUSE button causes the operation to change from play to pause or from pause back to play.
- The play operation of this CD player is performed via DSP (Digital Signal Processor) and memory, so
 the audio starts instantly after the PLAY/PAUSE button is pressed.
- Pressing the CUE button during disc play resets the CD to the position at which play was started. (This
 is called the back cue function.)

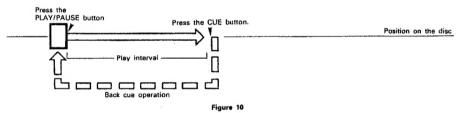
The steps through which disc play is performed when the PLAY/PAUSE and CUE buttons are pressed are described with the aid of the following illustrations in Figures 9 through 11.

PLAY and PAUSE



Pressing the PLAY/PAUSE button starts the disc play, the advancement of which is illustrated by the arrows of Figure 9. Pressing the PLAY/PAUSE button again during disc play causes the play operation to pause, and pressing this button once more causes the disc to be played again.

PLAY and CUE



Pressing the PLAY/PAUSE button starts the disc. Pressing the CUE button will reset the disc to the position where play was started. By alternately pressing the PLAY/PAUSE button and the CUE button, the disc may be played from the same position any number of times. This function is called back cue.

PLAY, PAUSE, and CUE

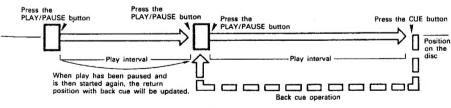


Figure 11

(6) Matching the Beats Per Minute

Match the pitch by monitoring the music of both CD-1 and CD-2 by ear. When the tempo of the music of the selected CD player is slow compared to the tempo of the other player, move the slider to the + side and match the tempo. When fast, move to the - side.

The following description is for the case of matching the pitch of CD-2 to the pitch of the music being played on CD-1.

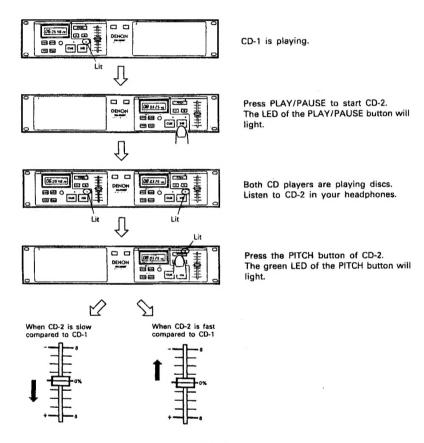


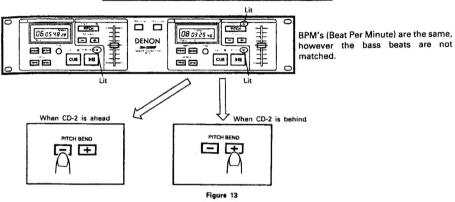
Figure 12

(7) Beat Matching Using Pitch Bend

A description of the procedure for matching the beat of CD-1 and CD-2 using the PITCH BEND button is given below.

This description is for the case of matching the beat of CD-2 to the beat of the music being played on CD-1.

After Matching the BPM's According to Section (6)



The pitch changes automatically while the + or button is being pressed. Releasing the button results in a return to the original pitch. (So the BPM's are once again the same.)

(8) Moving the Play Start Position

When a track is selected and the PLAY/PAUSE button is pressed, the play operation will start from the beginning of that track. However, when you want play to start from a different position, use the following procedure to find that position.

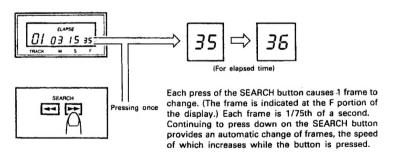


Figure 14

15

To Start Playback from the Middle of a track.

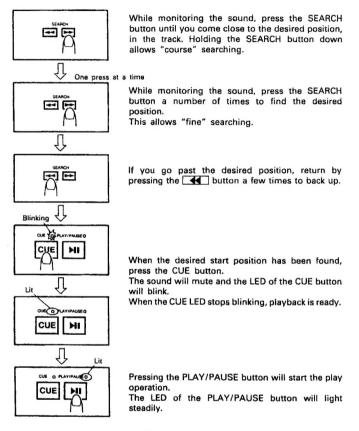
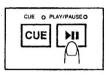


Figure 15

(9) Checking the Play Start Position

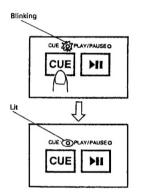
After selecting the track or after changing the play start position with the SEARCH button, use the following procedure to repeatedly check the position at which play will start.



Press the PLAY/PAUSE button. Check that play will start from the desired position.

NOTE

Once you have set up a new start position within a track, do not press the PAUSE or SEARCH buttons. Pressing these buttons will change your start position.



Press the CUE button after checking the start position.

The player will return to the position where play was started.

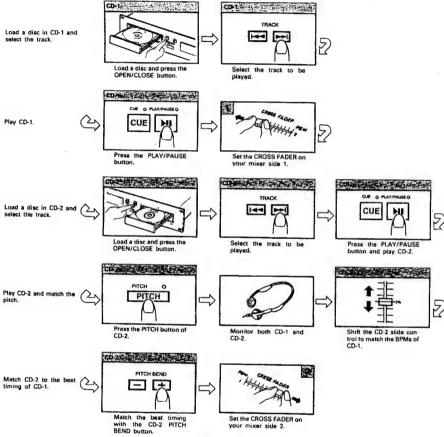
When the CUE LED stops blinking, it is ready to start again.

If the play start position is not to your liking, use the search function to change the position.

Figure 16

5 EXAMPLE OF MIXING WITH THE DN-2000F

A description of an actual example of mixing using the system illustrated in Figure 2 is given below. After playing back a track on CD-1, and after matching the pitch of CD-2, use cross fader on your mixer to fade from CD-1 to CD-2.

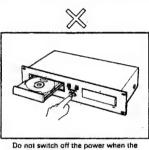


6 BEFORE SWITCHING OFF THE POWER

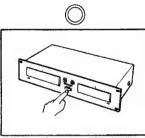
When you have finished using the CD player, before switching off the power be sure that the disc holder has been closed with the OPEN/CLOSE button.

CAUTION:

Do not forcibly close the disc holder when the power is off. It may damage the unit when it is transported.



disc holder is open. POWER OFF



Switch off the power after the disc holder has been closed with the OPEN/CLOSE button. POWER OFF

Figure 18

7 COMPACT DISCS

1. Precautions on handling compact discs

- . Do not allow fingerprints, oil or dust to get on the surface of the disc. If the disc is dirty, wipe it off with a soft dry cloth.
- We recommend using DENON's AMC-20/21 CD CLEANER:
- · Do not use benzene, thinner, water, record spray, electrostatic-proof chemicals, or silicone-treated cloths to clean discs.
- Always handle discs carefully to prevent damaging the surface; in particular when removing a disc from its case or returning it.
- . Do not bend the disc.
- · Do not apply heat.
- . Do not enlarge the hole in the center of the disc.
- · Do not write on the label (printed side) with a hard-tipped implement such as a pencil or ball
- · Condensation will form if a disc is brought into a warm area from a colder one, such as outdoors in winter. Do not attempt to dry the disc with a hair dryer, etc.

2. Precaution on storage

- · After playing a disc, always unload it from the
- · Always store the disc in the jewel case to protect from dirt or damage.
- . Do not place discs in the following areas:
- 1) Areas exposed to direct sunlight for a considerable time.
- 2) Areas subject to accumulation of dust or high humidity.
- 3) Areas affected by heat from indoor heaters, etc.

19

SPECIFICATIONS

GENERAL

Type:

Twin mechanism Compact

Disc player with wired

remote control.

Player unit;

Disc type:

Standard Compact Discs

(12 cm and 8 cm)

Dimensions:

 $482 (W) \times 88 (H) \times 252 (D) mm$

Remote control unit;

 $482 (W) \times 88 (H) \times 62 (D) mm$ 19-inch rack mountable

Installation:

Player unit; 3U

Remote control unit; 3U

Weight:

Player unit; 5.5 kg

Remote control unit; 1.5 kg

Power supply:

120 V AC ±10%, 60 Hz

(for U.S.A. & Canada models)

230 V AC $\pm 10\%$, 50/60 Hz (for European model) 240 V AC $\pm 10\%$, 50/60 Hz

(for U.K. model)

120/220/240 V AC ±10%,

50/60 Hz

(for multi voltage version)

Power consumption: 26 W

Environment:

Temperature; 5 to 35°C

Humidity; 25 to 85% (without condensation)

Storage Temperature; -20 to 60°C

Standard

Pin-connected cord;

accessories:

L/R 2 pairs

Remote connecting cable; 1 pc.

AUDIO SECTION

Quantization:

18-bit linear/channel

Sampling frequency: 44.1 kHz

Oversampling rate: 8 times Frequency response: 20 to 20,000 Hz

Total harmonic

distortion:

0.006 %

Signal-to-noise ratio: 103 dB Dynamic range:

98 dB

Channel separation: 96 dB

Output level:

2.0 V

Load impedance:

10 Kohm or more

FUNCTIONS

Track selection:

1 to 99 tracks

Fast search:

1 frame step and continuous search

Automatic cueing:

Beginning of music

Back cueing to cued point

Within 0.03 sec

Instant start: Variable pitch:

Display:

±8% Slider with resume switch

Pitch bend:

±8% max. Track number.

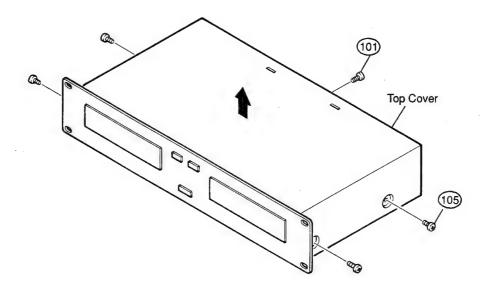
Remaining time or Elapsed time in Min. Sec. and Frame

^{*} Specifications and design are subject to change without notice for purpose of improvement.

DISASSEMBLY

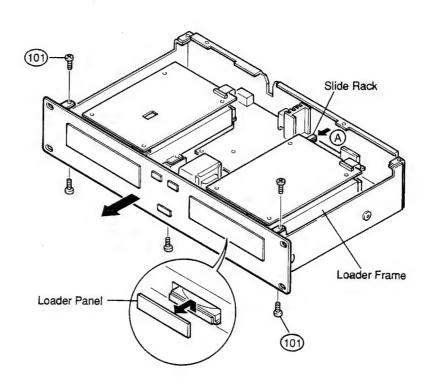
• TOP COVER

- 1. Remove 4 screws (105) on both sides, and 1 screw (101)
- on rear side.
- 2. Pull up TOP COVER.



• FRONT PANEL

- 1. LOADER FRAME comes out when SLIDE RACK (A) of mechanism unit is pushed.
- Pull up LOADER PANEL while pulling it towards front.
 Remove 2 upper screws 101 and 3 lower screws 101
- 4. Detach FRONT PANEL.



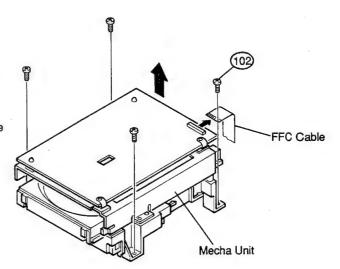
MECHANISM UNIT

- 1. Disconnect FFC cable.
- 2. Remove 4 screws (102)

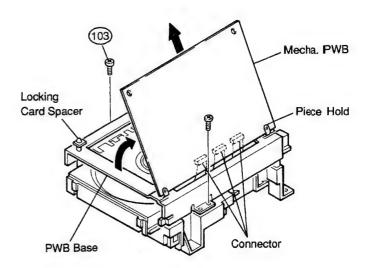
Note:
On not pull out aslant to prevent FFC cable damage.

 Do not fail to pull AC cord from wall outlet before disconnect the FFC cable.

IF AC cord is remained plugged into wall outlet, power is kept supplied in the unit, which may cause danger.



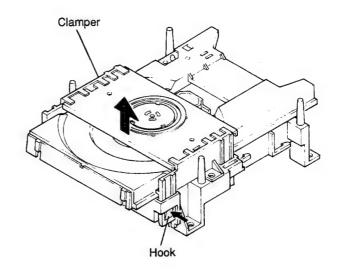
● MECHA. PWB and PWB BASE



- 1. Unlock Locking Card Spacer at two places.
- 2. Rotate Mecha.PWB upwards (approx. 45°), and take off from Piece Hold.
- 3. Remove 2 screws 103 on both sides, then PWB Base is detachable.

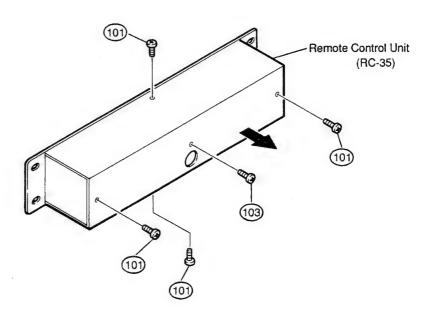
CLAMPER

Pull clamper and undo 4 hooks.



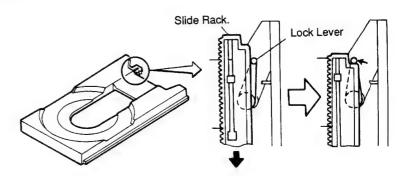
• COVER (REMOTE CONTROL UNIT)

1. Remove 5 screws (1 103 and 4 101).

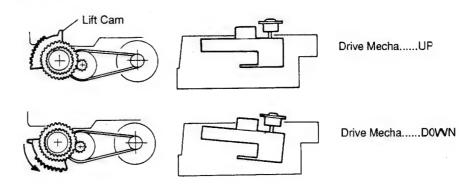


LOADER FRAME ASSEMBLING

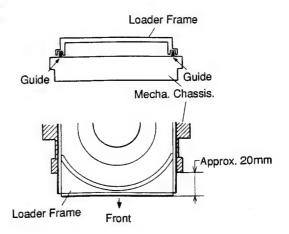
 Slide the slide rack located inner side of the loader frame, and set the lock lever as shown in the below figure.



Rotate the gear portion of lift cam counterclockwise by finger until it comes stopper part. At this time, confirm the drive mechanism that is placed in lowered position.

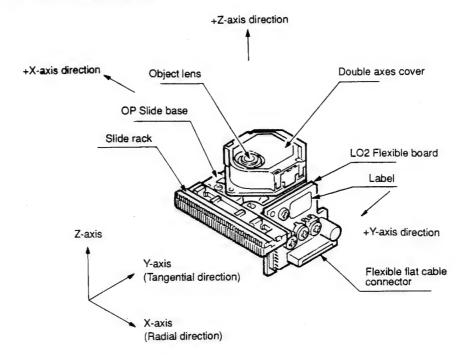


 Fit the guide of mechanism chassis and the ditch of loader frame and put the loader frame on the mechanism chassis. At this time, make sure that the front surface of the loader frame is set at 20mm extruded position from the front surface of mechanism chassis.

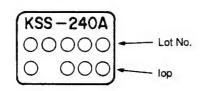


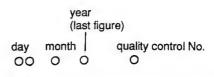
 Insert the clamper frame to the mechanism chassis until it locks.

NOTE FOR HANDLING OF LASER PICK-UP DESCRIPTION OF THE COMPONENTS







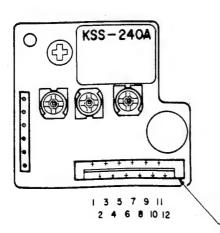


but Oct. Nov. and Dec. are expressed by alphabetical letters of $\boldsymbol{X},\,\boldsymbol{Y}$ and $\boldsymbol{Z}.$

quality control
$$\stackrel{}{\hspace{0.1cm}}$$
 0 0 0 0 0 LD drive current

The expressed unit is by mA, with omission of the decimal point as for example, 56.5mA will be expressed as 565, but the head of English letter means the control in the manufacturing plant.

PIN CONNECTOR



Flexible flat cable

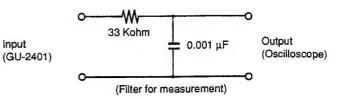
connector

Pin No.	Description	Input/ Output	Pin. No.	Description	liput/ Out put
1	VC (+2.5v)	OUT	7	Vcc (+5V)	IN
2	TE (TRK ER signal)	OUT	8	LDC (LD Control)	IN
3	FE (FCS ER signal)	OUT	9	FCS + (Double axes)	IIN
4	FZC (FZC signal)	OUT	10	TRK + (Double axes)	IN
5	RF (RF signal)	OUT	11	TRK - (Double axes)	IN
6	GND	IN	12	FCS - (Double axes)	IZ.
			ı		ł _

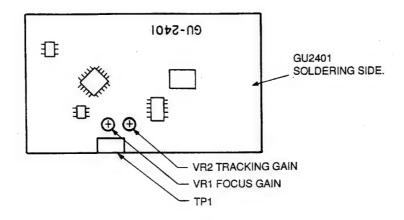
SERVO ADJUSTMENT

NECESSARY EQUIPMENTS FOR ADJUSTMENT

- 1. Dual trace oscilloscope
- 2. Reference disc CA1094
- 3. Oscillator (10Hz ~ 10kHz, 0 ~ 3 Vp-p)
- 4. Frequency Counter
- 5. Filter for measurement



LOCATION



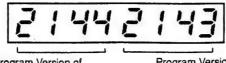
Adjustment Procedure

Be sure to perform servo adjustments and confirmations by this order of adjustment procedure.

- 1 Actuating the Service Program.
- 2 Confirmation of Tracking Offset.
- 3 Adjustment of Focus Gain.
- 4 Adjustment of Tracking Gain.
- 5 Confirmation of HF Waveform.

1. Actuating the Servo Program

- 1 Turn the power off.
- While simultaneously pushing the center blue buttons (1,2) of remote control (RC-35), turn the power on.
- ③ As the tray opens, set the adjustment disc (CA-1094).
- ① Displayed indication on the remote control (RC-35) is version number of microcomputer program 4 figures on the left are program version of remote control, and 4 figures on the right are program version of main body mechanism.

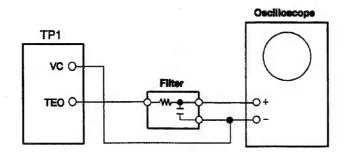


Program Version of Remote Control (RC-35) Program Version of Main Body Mechanism

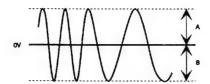
- ⑤ Push the TRACK button of the mechanism intended to adjust for one time. After confirm that a; is displayed, push the PLAY button. Then, the Tray will close.
- Push the TRACK button (2 is indicated), then push
 the PLAY button.

2. Confirmation of Tracking Offset

① Connections



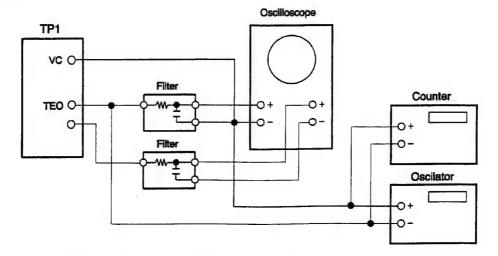
- ② Push the TRACK **b** button (**3** is indicated), then push the PLAY button.
- 3 Observe TEO on the scope.



Measure the voltage of A,B and in case $\frac{|A-B|}{A+B}$ exceeds 15%, please replace pick-up as it is defected.

3. Adjusment of Focus Gain

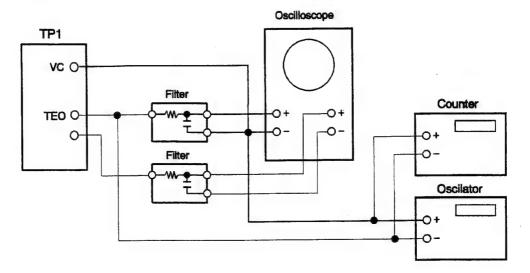
① Connections



- ② Push the TRACK **B**utton (**g**y is indicated), then push the PLAY button.
- 3 Set the oscillator 1.1kHz, 0.6 Vp-p mode.
- Make the oscilloscope in X-Y mode.
- (5) Adjust the VR1 (FOCUS) so as to symmetrize Lissajous figure to X axis or Y axis.

4. Adjustment of Tracking Gain

① Connections



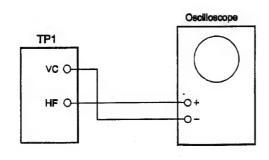
- ② Confirm that 04 is indicated.
- 3 Set the osillator 1.9kHz, 0.6Vp-p mode.
- Make the oscilloscope in X-Y mode.
- (5) Adjust the VR2 (TRACK) so as to symmetrize Lissajous figure to X axis or Y axis.

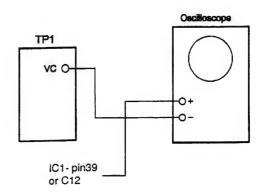
5. Confirmation of HF Waveform

① Connections

For PWB Item No. 222 2401 207

For PWB Item Nos. 222 2401 003 222 2401 100





- ② Observe HF waveform on the scope.
- 3 The standard amplitude of HF waveform is 1.1V. If it is less than 0.8V, please replace pick-up as it is defected.

6. Adjustment of Super Linear Converter

Adjustment of Super Linear Converter is only performed at a time the DA Converter is replaced.

Adjustment Procedure

① Connections

Connect the LINE OUT to a distortion meter through the low-pass filter.

- 2 Playback a disc obtains 1kHz, 0dB sine wave tone.
- 3 Adjust the VR300, VR301 and obtain minimum THD.

THD standard is less than 0.006%

About the Service Program

The service program is a program specially for servo adjustments and for confirmations.

Actuating the Service Program.

- 1 Turn the power off.
- ② While simultaneously pushing the center blue buttons (1,2) of remote control (RC-35), turn the power on.
- 3 Program version of microcomputer indicated on the remote control signifies start actuating of service program.

Contents of Service Program

After actuating the service program, select an aiming process number with the TRACK ([] bwl) buttons, TIME button, PITCH BEND button, and PITCH button, and push the PLAY button to execute processing, The process number is then displayed on the TRACK indication portion.

	Process No. (TRACK Indication)	Function	Contents Explanation
	01	OPEN/CLOSE	Performs OPEN/CLOSE each time the PLAY button is pushed.
	02	Slide	Moves pick-up to the center of disc.
TRACK	03	FOCUS SERVO ON	Turns the FOCUS Servo ON.
BUTTONS	04	Confirmation of TRACKING OFFSET	Rotates the disc. Checks divergence of Tracking Offset.
	05	Adjustment of Gain	Adjusts FOCUS, TRACKING Gains. Normally the same as PLAY MODE.
	06	Cleaning of Pick-up Lens	Pick-up. moves when SEARCH (►)button is pressed. Move the pick-up under the hole of mechanism PWB, and clean the lens.
TIME	0A	CHUCKING Test	Repeats OPEN/CLOSE of tray, servo ON, and TOC read.
PITCH BEND +	ОВ	Heat Run (No Skip Check)	Repeats OPEN/CLOSE of tray, repeats playing the first and the last programs of music on the disc. When an error occurs, displays error coeand stops.
PITCH BEND	0C	Heat Run (With Skip Check)	Repeats OPEN/CLOSE of tray, repeats playing the first and the later program of music on the disc. Stops when skip (track jump) occurs.

IC TERMINAL FUNCTION LIST

TABLE OF MICROCOMPUTER (IC800) TERMINALS

IC800 is utilizing an external ROM in its initial lot until using the mask item. As the contents of same terminals differ according to the lot for this reason, please be reminded at a time performing service. External ROM utilizing models are up to these serial numbers listed below.

Model EUROPE Serial No. ~ 881, 886 ~ 950

U.K. ~ 300 U.S.A. ~ 620 Model CANADA Multi-Voltage Serial No. ~ 130

~ 100

Terminal No.	Symbol Name	1/0	Terminal Function		
1	CUEL2	0	CUE LED ON/OFF signal of CD-2. ON at "H".		
2	PLYL2	0	PLAY LED ON/OFF signal of CD-2. ON at "H".		
3	PITL2	0	PITCH LED ON/OFF signal of CD-2. ON at "H".		
4	PITL1	0	PITCH LED ON/OFF signal of CD-1. ON at "H".		
5	PLYL1	0	PLAY LED ON/OFF signal of CD-1. ON at "H".		
6	CUEL1	0	CUE LED ON/OFF signal of CD-1. ON at "H".		
7	RST-	ı	Hard reset input. Reset at "L".		
8	Vpp	_	+5V power supply.		
9	X2	1	Clock oscilation circuit input 2.		
10	X1	1	Clock oscilation circuit input 1.		
11	V _{SS}	_	0V power supply.		
12	Vss	_	0V power supply.		
13	_		Not connected.		
14	LCE2	0	Chip enable signal of CD-2's LCD driver.		
15	LCLK2	0	Command transmitting clock for CD-2's LCD driver.		
16	LDAT2	0	Command data for CD-2's LCD driver.		
17	LCE1	0	Chip enable signal of CD-1's LCD driver.		
18	LCLK1	0	Command transmitting clock for CD-1's LCD driver.		
19	LDAT1	0	Command data for CD-1's LCD driver.		
20	_	0	Not used. Fixed to "L".		
21		_	Not Connected.		
22	_	0	Not used. Fixed to "L".		
-23		0	Not used. Fixed to "L".		
24	_	0	Not used. Fixed to "L".		
25	WR-	0	Not used. Mask item fixed to "L", external ROM fixed to "H".		
26	OE-	0	Enable signal output for external ROM. Mask item fixed to "L", external ROM pulse output fot reading.		
27	KOUT3	0	Key matrix scan signal 3.		
28	KOUT2	0	Key matrix scan signal 2.		
29	KOUT1	0	Key matrix scan signal 1.		
30	KOUT0	0	Key matrix scan signal 0.		
31			Not connected.		
32	A15	0	Memory address 15. Not used. Mask item fixed to "L".		
33	A14	0	Memory address 14. Mask item fixed to "L".		
34	A13	0	Memory address 13. Mask item fixed to "L".		
35	_		Not connected.		
36	A12	0	Memory address 12. Mask item fixed to "L".		
37	A11	0	Memory address 11. Mask item fixed to "L".		
38	A10	0	Memory address 10. Mask item fixed to "L".		
	1	+			

Memory address 9. Mask item... fixed to "L".

Memory address 8. Mask item... fixed to "L".

0

0

Not connected.

Α9

Α8

40

41

Terminal No.	Symbol Name	1/0	Terminal Function	
42	AD7	1/0	Data bus 7. Mask item fixed to "L".	
43	AD6	1/0	Data bus 6. Mask item fixed to "L".	
44	AD5	1/0	Data bus 5. Mask item fixed to "L".	
45	AD4	1/0	Data bus 4. Mask item fixed to "L".	
46	AD3	1/0	Data bus 3. Mask item fixed to "L".	
47	AD2	1/0	Data bus 2. Mask item fixed to "L".	
48	AD1	1/0	Data bus 1. Mask item fixed to "L".	
49	ADO	1/0	Data bus 0. Mask item fixed to "L".	
50	ASTB	0	Pulse for address latch. Mask item fixed to "L".	
51	Vss		0V power supply.	
52	Vss		OV power supply.	
53	VSS —		Not connected.	
54	MODE	 		
55		1	Memory mode selection terminal. Use external ROM at "H", use mask ROM at "L". Mask item "L", external ROM "H".	
		 -	Not connected.	
56		1 1	Not used.	
57		1	Not used.	
58		1	Not used.	
59			Not used.	
60		 - -	Not connected.	
61		1	Not used.	
62	_	1	Not used.	
63	-	1	Not used.	
64		1	Not used.	
65	V _{DD}	 -	+5v power supply.	
66	V _{DD}		+5v power supply.	
67	PIT1	1	CD-1 pitch volume input.	
68	PIT2	1	CD-2 pitch volume input.	
69	_	I	Not used. Fixed to "L".	
70			Not connected.	
71	_	1	Not used. Fixed to "L".	
72		1	Not used. Fixed to "L".	
73		1	Not used. Fixed to "L".	
74		1	Not used. Fixed to "L".	
75	_	1	Not used. Fixed to "L".	
76	AV _{DD}	_	+5v power supply for A/D converter	
77	AVREF1		+5V. A/D converter reference voltage.	
78	_	_	Not connected.	
79	AVSS	_	0V power supply for A/D converter.	
80		0	Not used.	
81		0	Not used.	
82	AVREF2	_	+5V. D/A converter reference voltage.	
83	AVREF3	_	0V. D/A converter reference voltage.	
84	_	_	Not connected.	
85	KIN10	1	CD-1 key data 0.	
86	KIN11	ı	CD-1 key data 1.	
87	KIN12	1	CD-1 key data 2.	
88	KIN13	ı	CD-1 key data 3.	
89	KIN20	ı	CD-2 key data 0.	
90	KIN21	ı	CD-2 key data 1.	
91	KIN22	1	CD-2 key data 2.	
92	KIN23	1	CD-2 key data 3.	
93	RXD-	1	Serial interface reception data.	
94	TXD-	0	Serial interface transmission data.	
		Ŭ	HEIDINGON WALL	

TABLE OF MICROCOMPUTER µPD78233GJ-5BG(IC200) TERMINALS

Model

CANADA

Multi-Voltage

IC200 is utilizing an external ROM in its initial lot until using the mask item. As the contents of some terminals differ according to the lot for this reason, please be reminded at a time performing service. External ROM utilizing models are up to these serial numbers listed below.

Model EUROPE

U.K. U.S.A. Serial No.

~ 620

~ 881, 886 ~ 950 ~ 300

Serial No. ~ 130 ~ 100

Terminal No.	Symbol Name	1/0	Terminal Function		
1	_				
2	RST2	0	Reset signal of IC201(µPD6381GF).		
3	BRRQ	Ö	Break request signal of IC201(μPD6381GF). Not used. Fixed to "H".		
4	BRAK	1	Break acknowledge signal of IC201(μPD6381GF). Not used. Fixed to "H".		
5	GF	1	?		
6	so	1	IC201 serial data input.		
7	RST-	1	Hard reset input. Reset at "L".		
8	V _{DD}	_	+5V power supply.		
9	X2	ı	Clock oscillation circuit input 2.		
10	X1	1	Clock oscillation circuit input 1.		
11	Vss		0V power supply.		
12	Vss		0V power supply.		
13	_	_	Not connected.		
14	CLOK	0	Clock for servo command, level command. Connected to IC1, IC300.		
15	DATA	0	Data for servo command, level command. Connected to IC1, IC300.		
16	XLAT	0	Latch pulse of servo command. Latched at falling edge.		
17	_	0	Not used. Fixed to "L".		
18	LDON	0	Laser ON/OFF signal of optical pickup. Laser emits light at "H".		
19	_	0	Not used. Fixed to "L".		
20	_	0	Not used. Fixed to "L".		
21	_	_	Not connected.		
22	_	0	Not used. Fixed to "L".		
23	DRNO-	1	Mechanism number input. Mechanism 1 at "L", mechanism 2 at "H".		
24	TXDEN	0	Demand signal of serial interface using. Used at "H".		
25	_	0	Not used. Mask item — fixed to "L", external ROM — fixed to "H".		
26	OE-	0	Output enable signal for external ROM. Mask item — fixed to "L", external ROM — pulse output for reading.		
27	CS-	0	Chip select signal of IC201. Normally "H". "L" at select only.		
28	C-/D	0	Command/data designate signal of IC201. Command at "L", indicates data transmitting mode at "H".		
29	SCK-	0	Clock for command transmission to IC201.		
30	SI	0	Command data to IC201.		
31		_	Not connected.		
32	A15	0	Memory address 15. Not used. Mask item — fixed to "L".		
33	A14	0	Memory address 14. Mask item — fixed to "L".		
34	A13	0	Memory address 13. Mask item — fixed to "L".		
35	_	_	Not connected.		
36	A12	0	Memory address 12. Mask item — fixed to "L".		
37	A11	0	Memory address 11. Mask item — fixed to "L".		
38	A10	0	Memory address 10. Mask item — fixed to "L".		
39	A9	0	Memory address 9. Mask item — fixed to "L".		
40	A8	0	Memory address 8. Mask item — fixed to "L".		
41	-	_	Not connected.		
42	AD7	1/0	Data bus 7. Mask item — fixed to "L".		
43	AD6	1/0	Data bus 6. Mask item — fixed to "L".		

Terminal No.	Symbol Name	1/0	Terminal Function		
44	AD5	1/0	Data bus 5. Mask item — fixed to "L".		
45	AD4	1/0	Data bus 4. Mask item — fixed to "L".		
46	AD3	1/0	Data bus 3. Mask item — fixed to "L".		
47	AD2	1/0	Data bus 2. Mask item — fixed to "L".		
48	AD1	1/0	Data bus 1. Mask item — fixed to "L".		
49	AD0	1/0	Data bus 0. Mask item — fixed to "L".		
50	ASTB	0	Pulse for address latch. Mask item — fixed to "L".		
51	Vss		0V power supply.		
52	Vss	_	0V power supply.		
53			Not connected.		
54	MODE	ı	Memory read select terminal. External ROM use at "H", mask ROM use at "L". Mask item — "L", external ROM — "H".		
55	_		Not connected.		
56	AMUTE	0	Audio output mute signal. Mute at "H".		
57	SQCK	0	Clock for sub—code reading.		
58	SENS	1	Indication signal of servo actuating condition. Emits from IC2.		
59	CLOSE-	ı	Tray CLOSE switch. CLOSE state at "L".		
60	_	_	Not connected.		
61	OPEN-	1	Tray OPEN switch. OPEN state at "L".		
62	sqso	1	Sub—code data input. Emits from IC2.		
63	DFLAT	0	Command latch pulse for digital filter. Output to IC300.		
64		0	Not used. Fixed to "H".		
65	V _{DD}	_	+5v-power supply.		
66	V _{DD}		+5v power supply.		
67	LDIN	1	Analog input for tray drive servo.		
68	STIN	1	Input for between microcomputers communication. Connected to STOUT of the other mechanism microcomuter. To communicate with 3 kinds of voltages, i.e. 0V, 2.5V, 5V.		
69		1	Not used. Fixed to "L".		
70	_		Not connected.		
71		1	Not used. Fixed to "L".		
72		1	Not used. Fixed to "L".		
73		- 1	Not used. Fixed to "L".		
74	_	1	Not used. Fixed to "L".		
75		ı	Not used. Fixed to "L".		
76	AV _{DD}	_	+5V power supply for A/D converter.		
77	AVREF1	_	+5V. A/D converter reference voltage.		
78		_	Not connected.		
79	AVss	_	.0V power supply for A/D converter.		
80	LOADER	0	Tray drive signal. Stops at 2.5V, CLOSE action at 3V, OPEN action at 2V.		
81	STOUT	0	Output for microcomputer communication. Connects to STIN of the other microcomputer. Communicates with 3 kinds of voltages, i.e. OV, 2.5V, 5V.		
82	AVREF2	-	+5V. D/A converter reference voltage.		
83	AVREF3	_	0V. D/A converter reference voltage.		
84		_	Not connected.		
85	_	1	Not used. Fixed to OV.		
86	EJSW-	1	EJECT/OPEN switch input. Connected to the switch of front panel. Shifts to "L" when the switch is pressed.		
87	RST	ı	Input for +5V voltage observation. Shifts to "H" when POWER switch is turned off.		
88	WFCK	ı	Connected to WFCK output of IC2. 7.35kHz clock.		
89	SCOR	1	Sub-code sink input. Connect to IC2. Input 75 pulses per 1 second.		
90	DRDY	ı	Data receiving READY signal of IC201. Fixed to "H".		
91		1	Not used. Fixed to "L".		
92	OVF-	1	Over flag of IC201. Normally "H".		
93	RXD-	1	Serial interface reception data.		
94	TXD-	0	Serial interface transmission data.		

TABLE OF DIGITAL SIGNAL PROCESSOR $\mu PD6381GF$ (IC201) TERMINALS

Terminal No.	Symbol Name	1/0	Terminal Function		
1	DRDY	0	Command reception READY signal from microcomputer. Normally "H".		
2	FSMASK	1	LRCK mask signal. Fixed to "L".		
3	SEL	ı	Clock input select. Fixed to "H".		
4		1	Not used.		
5	ХО	0	X'tal oscillation output.		
6	XI	1	X'tal oscillation input.		
7	GND	-	0V power supply.		
8	XFSO	0	Clock Output. Not used.		
9			Not connected.		
10	LRCKO	0	LR clock output. 44.1kHz.		
11	WCLKO	0	Word clock output. 88.2kHz. Not used.		
12	BCLKO	0	Bit clock output. 2.1MHz.		
13	BRAK-	0	Break acknowledge output. Fixed to "H".		
14	GND	_	OV power supply.		
15	BRRQ-	i	Break request input. Fixed to "H".		
16	FSRST-	ı	Program counter reset input. Fixed to "H".		
17	RST2-	t	Soft reset input, Normally "H".		
18	RST-	i	Hard reset input. Normally "H".		
19	A0	0	External RAM address 0.		
20	A1	0	External RAM address 1.		
21	A2	0	External RAM address 2.		
22	A3	0	External RAM address 3.		
23	A4	0	External RAM address 4.		
24	A5	0	External RAM address 5.		
25	A6	0	External RAM address 6.		
26	A7	0	External RAM address 7.		
27	A8	0	External RAM address 8.		
28	A9	0	External RAM address 9. Not used.		
29	A10	0	External RAM address 10. Not used.		
-30	A11	0	External RAM address 11. Not used.		
31	A12	0	External RAM address 12. Not used.		
32	A13	0	External RAM address 13. Not used.		
33	V _{DD}		+5V power supply.		
34	A14	0	External RAM address 14. Not used.		
35	A15	0	External RAM address 15. Not used.		
36	A16	0	External RAM address 16. Not used.		
37	RAS-	0	External RAM low address strobe signal.		
38	CAS-	0	External RAM column address strobe signal.		
39	WE-	0	External RAM write enable signal.		
40	101	1/0	External RAM data 1.		
41	102	1/0	External RAM data 2.		
42	103	1/0	External RAM data 3.		
43	104	1/0	External RAM data 4.		
44	105	1/0	External RAM data 5. Not used.		
45	106	1/0	External RAM data 6. Not used.		
46	107	I/O	External RAM data 7. Not used.		
47	108	1/0	External RAM data 8. Not used.		
48	109	1/0	External RAM data 9. Not used.		
49	1010	1/0	External RAM data 10. Not used.		
50	1011	1/0	External RAM data 11. Not used.		
			External RAM data 12. Not used.		

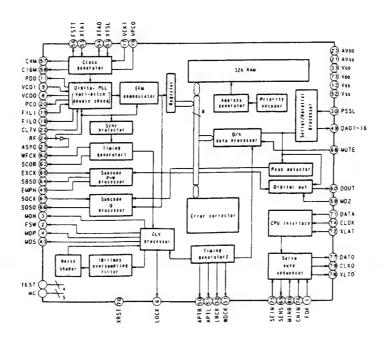
Terminal No.	Symbol Name	1/0	Terminal Function			
52	1013	1/0	External RAM data 13. Not used.			
53	1014	1/0	nal RAM data 14. Not used.			
54	1015	1/0	External RAM data 15. Not used.			
55	1016	1/0	External RAM data 16. Not used.			
56	GND	_	0V power supply.			
57	MD0	I	Mode select 0. Fixed to "L".			
58	MD1	1	Mode select 1. Fixed to "H".			
59	MD2	1	Mode select 2. Fixed to "L".			
60	BCLK1	t	Bit clock input. 2.18MHz.			
61	LRCK1	1	LR clock input. 44.1kHz.			
62	BCLK2	1	ed to "L". Not used.			
63	LRCK2	1	Fixed to "L". NOt used.			
64	DI1	1	Data input.			
65	DO1	0	Data output.			
66	DI2	1	Fixed to "L". Not used.			
67	DO2	0	Not used.			
68	DO3	0	Not used.			
69	DORQ-	1	Not used. Fixed to "H".			
70	GF-	0	G flag output. Normally "H".			
71	OVF-	0	Over flag output. Normally "H".			
72	V _{DD}	_	+5V power supply.			
73	TEST0	1	Fixed to "H".			
74	TEST1	1	Fixed to "H".			
75	SETRDY	0	Not used.			
76	SO	0	Serial data output.			
77	SCK-	1	Serial data input/output clock.			
78	SI	1	Serial data input.			
79	C-/D	ı	Command /data designation signal. "L" - command, "H" - data.			
80	CS-	1	Chip select input.			

CXD2500AQ Terminal Function

Terminal No.	Symbol	1/0		Terminal Function
1	FOK	ı		Input terminal for OK focussing. Use for Servo-autosequencer.
2	FSW	0	Z,0	Output to shift time constant of output filter for spindle motor.
3	MON	0	1,0	ON/OFF control output for spindle motor.
4	MDP	0	1,Z,0	Servo control for spindle motor.
5	MDS	0	1,Z,0	Servo control for spindle motor.
6	LOCK	0	1,0	Sampling GFS by 460 Hz and if it is "H", delivers "H"; if it is continuously "L" 8 times, delivers "L".
7	NC		_	
8	vcoo	0	1,0	Oscillation current output for analog EFM PLL.
9	VCOI	ī	.,.	Oscillation current output for analog EFM PLL. f LOCK=8.6436MHz.
10	TEST			TEST output. Normally GND.
11	PDO	0	1,Z,0	Charge pump output for analog EFM PLL.
12	Vss	<u> </u>	11210	GND.
13	NC			
	NC			
14		1		
15	NC	0	1,Z,0	Charge pump output for variable pitch PLL.
16	VPCO		1,4,0	Clock input from external VCO for variable pitch. fc center=16.9344MHz.
17	VCKI	0	A !	Filter output for master PLL. (slave=digital PLL)
18	FILO	0	Analog	Filter input for master PLL. (slave=uightal r EL)
19	FILI	1	-	
20	PCO	-	1,Z,0	Charge pump output for master PLL.
21	AVss		T	Analog GND.
22	CLTV			Control voltage input for master VCO.
23	AVDD		1	Analog power supply (+5V).
24	RF	1	-	EFM signal input.
25	BIAS	1		Constant-current input for Asymmetry circuit.
26	ASYI	1		Comparate voltage input for Asymmetry.
27	ASYO	0	1,0	Full swing output for EFM. (L=Vss, H=VDD).
28	ASYE	ı		L: Asymmetry circuit → OFF. H: Asymmetry cirquit → ON.
29	NC		_	
30	PSSL	1		Input to shift output mode of audio data. Serial output at L; parallel output at H.
31	WDCK	0	1,0	D/A Interface for 48 bit slot. Word-clock f≖2 Fs.
32	LRCK	0	1,0	D/A Interface for 48 bit slot. LR-clock f= Fs.
33	Voo			Power supply (+5V).
34	DA16	0	1,0	At PSSL=1 for DA16 (MBS) output; PSSL=0 for serial data of 48 bit slot. (2s'COMP, MSB first).
35	DA15	0	1,0	At PSSL=1 for DA15 output; PSSL=0 for bit clock of 48 bit slot.
36	DA14	0	1,0	At PSSL=1 for DA14 output; PSSL=0 for serial data of 64 bit slot. (2s'COMP, LSB first).
37	DA13	0	1,0	At PSSL=1 for DA13 output; PSSL=0 for bit clock of 64 bit slot.
38	DA12	0	1,0	At PSSL=1 for DA12 output; PSSL=0 for LR clock of 64 bit slot.
39	DA11	0	1,0	At PSSL=1 for DA11 output; PSSL=0 for GTOP output.
40	DA10	0	1,0	At PSSL=1 for DA10 output; PSSL=0 for XUGF output.
41	DA09	0	1,0	At PSSL=1 for DA09 output; PSSL=0 for XPLCK output.
42	DA08	0	1,0	At PSSL=1 for DA08 output; PSSL=0 for GFS output.
43	DA07	0	1,0	At PSSL=1 for DA07 output; PSSL=0 for RFCK output.
44	DA06	0	1,0	At PSSL=1 for DA06 output; PSSL=0 for C2PO output.
45	DA05	0	1,0	At PSSL=1 for DA05 output; PSSL=0 for XRAOF output.
 	DA03	0	1,0	At PSSL=1 for DA04 output; PSSL=0 for MNT3 output.
46		0	1,0	At PSSL=1 for DA03 output; PSSL=0 for MNT2 output.
47	DA03	0	1,0	At PSSL=1 for DA02 output; PSSL=0 for MNT1 output.
48	DA02			At PSSL=1 for DA01 output; PSSL=0 for MNT0 output.
49	DA01	10	1,0	Control output for aperture compensation. In H for R-ch.
50	APTR		1,0	Control output for aperture compensation. In H for L-ch.
51	APTL	0	1,0	Control output for apartities componentials. In 11 to 2 cm

Terminai No.	Symbol	1/0		Terminal Function
52	Vss			GND.
53	XTAI	1		X'tal oscillation circuit input. By selecting of mode, f=16.9344MHz or 33.8688MHz.
54	XTAO	0	1,0	X'tal oscillation circuit input. f=16.9344MHz.
55	XTSL	1		Selection input terminal of X'tal. "L" for X'tal 16.9344MHz; H for 33.8688MHz.
56	FSTT	0	1,0	2/3 Dividing output of 53 and 54 terminal. No change by variable pitch.
57	C4M	0	1,0	4.2336MHz output. When variable pitched, simultaneously changes.
58	C16M	0	1,0	16.9344MHz output. When variable pitched, simultaneously changes.
59	MD2	1		Digital-out ON/OFF control. ON at H; OFF at L.
60	DOUT	0	1,0	Digital-out output terminal.
61	EMPH	0	1,0	When playback disc emphasized, outputs H; otherwise outputs L.
62	WFCK	0	1,0	WFCK (Write Flame Clock) output.
63	SCOR	0	1,0	Output of subcode sync. S0+S1. H output when either one detected.
64	SBSO	0	1,0	Serial output of Sub P~W.
65	EXCK	1.		Clock iutput for SBSO read-out.
66	SQSO	0	1,0	Output for Sub Q 80 bits and PCM peak level 16 bits.
67	SQCK	1		Clock input for SQSO read-out.
68	MUTE	ł		Mute at H; remove mute at L.
69	SENS	_	1,Z,0	SENS output. Outputs to CPU.
70	XRST	ı		System reset input. Resets at "L".
71	DATA	ı		Input of serial data from CPU.
72	XLAT	ı		Input for latch from CPU. Latches serial data at release.
73	Voo			Power supply (+5V).
74	CLOK	1		Serial data transfer clock input from CPU.
75	SEIN	1		SENS input from SSP.
76	CNIN	1		Input of tracking pulse.
77	DATO	0	1,0	Serial data output to SSP.
78	XLTO	0	1,0	Serial data latch output to SSP.
79	CLKO	0	1,0	Serial data transfer clock output to SSP.
80	MIRR	ı		Mirror signal input. Use for track jump for over 128 tracks, using autosequencer.

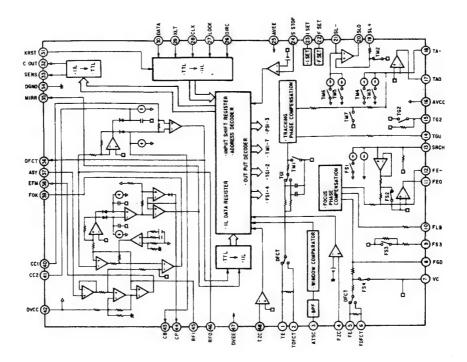
CXD2500AQ



CXA1372Q Terminal Function

Terminal No.	Symbol	1/0	Terminal Function					
1	Vc	1	Mid-point voltage input terminal.					
2	FGD	ı	In case of reducing higher range gain of focus servo, connect a capacitor between this terminal and terminal number (9).					
3	FS3	1	Shifts higher range gain of focus servo by FS3 ON/OFF.					
4	FLB	1	Terminal for external time constant to increase lower range of focus servo.					
5	FEO	0	Focus drive output.					
6	FE-	1	Reverse input terminal for focus amplifier.					
7	SRCH	1	Terminal for external time constant to make focus search waveform.					
8	TGU	ı	Terminal for external time constant to shift higher range gain of tracking.					
9	TG2	1	Terminal for external time constant to shift higher range gain of tracking.					
10	TAO	0	Tracking drive output.					
11	TA-	1	Reverse input terminal for tracking amplifier.					
12	SL+	1	Non-reverse input terminal for sled amplifier.					
13	SLO	0	Sled drive output.					
14	SL-	1	Reverse input terminal for sled amplifier.					
15	FSET	i	Terminal to compensate peak in focus/tracking phase.					
17	ISET		Delivers a current to set the height of focus search, track jump, and sled kick.					
18	SSTOP	1	Terminal for limit switch ON/OFF to detect disc innermost circle.					
19	DIRC	1	Terminal is used at the time of 1 track jump. A 47 kohm pull up resistor is included.					
20	LOCK	i	Reckless drive protection circuit of sled; activates at "L". A 47k ohm pull up resistor is included.					
21	CLK	1	Serial data transfer clock input from CPU.					
22	XLT	1	Latch input from CPU.					
23	DATA		Serial data input from CPU.					
24	XRST	· ·	Reset input terminal. Resets at "L".					
26	C.OUT	0	Terminal to output signal for track number count.					
27	SENS	0	Terminal to output FZC, AS, TZC, SSTOP by command from CPU.					
29	MIRR	0	Output terminal for MIRR comparator.					
30	DFCT	0	Output terminal for DEFECT comparator.					
31	ASY	1	Input terminal for auto-symmetric control.					
32	EFM	0	Output terminal for EFM comparator.					
33	FOK	0	Output terminal for focus OK (FOK) comparator.					
34	CC1	0	DEFECT bottom hold output terminal.					
35	CC2	1	Input terminal to input DEFECT bottom hold output by capacitance combination.					
37	CB		Capacitor connecting terminal for DEFECT bottom hold.					
38	СР	1	MIRR hold capacitor connecting terminal. A non-reverse input terminal for MIRR comparator.					
39	RFI	1	Input terminal to input RF summing amplifier output by capacitance combination.					
40	RFO	0	Output terminal for RF summing amplifier. Check point for eye pattern.					
		1	Tracking zero-cross comparator input terminal.					
42	TZC TE		Tracking error signal input terminal.					
			Capacitor connecting terminal for time constant at the time of defect.					
44	TDFCT							
45	ATSC	1	Input terminal of ATSC detecting window comparator.					
46	FZC		Input terminal of focus zero-cross comparator.					
47	FE FDFCT	1	Focus error signal input terminal. Capacitor connecting terminal for time constant at the time of defect.					

CXA1372Q



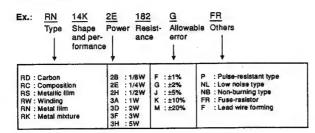
NOTE FOR PARTS LIST

- Part indicated with the mark " " are not always in stock and possibly to take a long period of time for supplying, or in some case supplying of part may be refused.
- When ordering of part, clearly indicate "1" and "I" (i) to avoid mis-supplying.
- Ordering part without stating its part number can not be supplied.
- Part indicated with the mark "★" is not illustrated in the exploded view.

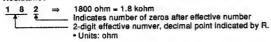
WARNING:

Parts marked with this symbol 🛦 📷 have critical characteristics. Use ONLY replacement parts recommended by the manufacturer.

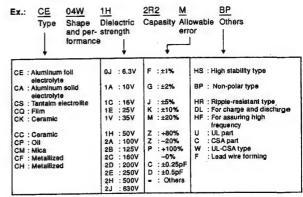
Resistors



Resistance



Capasitors



Capasity

- 2 R 2 1-digit effective number, decimal point indicated by R.

 2-digit effective numver, decimal point indicated by R.
- Units: μF, (for P, pF (μμF))
 When the dielectric strength is indicated in AC, "AC" is included after

PRINTED WIRING BOARD PARTS LIST GU-2403 CONTROL PWB UNIT

Ref No.	Part No.	Part Name	Remarks	Ref No.	Part No.	Part Name	Remarks	
SEMICON	NDUCTORS	GROUP		RESISTORS GROUP (Not included Carbon Film ±5% 1/4W)				
	262 1473 001		U.S.A. Model Serial No620	R801	247 0005 905	Chip 100ohm 1/4W	RM73B-101J	
10000	202 1110 001		Europe Model Serial No.~881	R802	247 0008 902	Chip 18Kohm 1/10W	RM73B182J	
			No.886~950	R804	247 0011 944	Chip 47Kohm 1/10W	RM73B-473J	
			U.K. Model Serial No.~300	R805	247 0011 944	Chip 47Kohm 1/10W	RM73B-473J	
			Canada Model Serial No.~130				U.S.A. Model Serial No.~620	
			Multi-Voltage Model				Europe Model Serial No.~881	
			Serial No.~100				No.886~950	
IC800	262 1691 003	IC μPD	U.S.A. Model Serial No.621~				U.K. Model Serial No.~300	
		78234GJ-516-5BG	Europe Model Serial No.882~885				Canada Model Serial No.~130	
			No.951~				Multi-Voltage Model No.~100	
			U.K. Model Serial No.301~		0.47.0007.045	Ohin 4 Vahra 4/40M	RM73B-102J	
			Canada Model Serial No.131~	R806,807	247 0007 945	Chip 1Kohm 1/10W	RM73B-473J	
			Multi-Voltage Model	R810~813		Chip 47Kohm 1/10W	RM73B-513J	
			Serial No.101~	R814	247 0011 957	Chip 51 Kohm 1/10W Chip 330Kohm 1/10W	RM73B-334J	
IC801	262 1597 903	IC M5M34051FP		R815	247 0013 942	Chip 470ohm 1/10W	RM73B-471J	
IC802,803	263 0533 000	IC LC7582		R816	247 0006 962	Chip 220ohm 1/10W	RM73B-221J	
IC804	262 0943 901	IC HD74HC373FP-TL	U.S.A. Model Serial No.~620	R817,818	247 0005 989 247 0003 965	Chip 27ohm 1/10W	RM73B-270J	
			Europe Model Serial No811	R819,820	247 0003 965	Chip 27ohm 1/10W	RM73B-270J	
			No.886~950	R823,824	247 0003 965	Chip 47Kohm 1/10W	RM73B-473J	
			U.K. Model Serial No.~300		247 0011 944	Chip 51 Kohm 1/10W	RM73B-513J	
			Canada Model Serial NoI30	R834 R835	247 0011 937	Chip 330Kohm 1/10W	RM73B-334J	
			Multi-Voltage Model	R836	247 0013 942	Chip 470ohm 1/10W	RM73B-471J	
			Serial No.~I00	R837,838	247 0005 989	Chip 220ohm 1/10W	RM73B-221J	
IC805 _	205 0488 010	IC 28P IC SOCKET	U.S.A. Model Serial No.~620	R839,840	247 0003 965	Chip 27ohm 1/10W	RM73B-270J	
-	GEN 2144	CONTROL ROM	Europe Model Serial No.~881	11003,040	247 0000 300	0p 2./ 0		
		SUB Ass'Y	No.886~950	VR810	211 0763 015	Slide Volume		
			U.K. Model Serial No.~300	VR830	211 0763 015	Slide Volume		
			Canada Model Serial No.~130	'''				
			Multi-Voltage Model					
			Serial No.~100	CARAC	ITORS GRO	ID		
IC806	262 1647 905	IC MN1382-S(TX)					07705454047	
10000		,		C800	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1E104Z	
TR800805	269 0082 902	Transistor DTC114EK		C801	254 4260 980	Electrolytic 10µF/50V	CE04W1H100M(SME) CK73F1E104Z	
,,,,,,				C810,811	257 0014 935	Ceramic-chip 0.1µF/25V		
D800,801	276 0438 949	Diode MA151WK		C812	257 0006 969	Ceramic-chip 680pF/50V	CK73F1E104Z	
D802,803	276 0438 907	Diode MA151WA		C830,831	257 0014 935	Ceramic-chip 0.1μF/25V Ceramic-chip 680pF/50V		
D804~815	276 0438 910	Diode MA151A		C832	257 0006 969 257 0014 935	Ceramic-chip 0.1µF/25V		
				C842,843	257 0014 935	Ceramic-chip 0.1µF/25V		
LE810	393 9511 104	LED BACK LIGHT	(CD-1)	U861~800	257 0014 935	Ceramic-Grap 6.1µ17254	01001121042	
LE811	393 9462 017	LED SLR-40VC3F(RED)	CUE Monitor(CD-1)					
LE812,813	393 9512 006		PLAY/PAUSE,PITCH Monitor	OTHER	S PARTS GE	ROUP	1	
		(GRN)	(CD-1)	X800	399 0038 008	Ceramic Vibrator	CST12.0M	
LE830	393 9511 104		(CD-2)	SW811-82	22 212 4763 904	TACT SWITCH (LONG ST)	
LE831	393 9462 017		CUE Monitor(CD-2)	SW830~84	41 212 4763 904	TACT SWITCH (LONG ST)	
LE832,833	393 9512 006	LED SLR-40MC(GRN)	PLAY/PAUSE,PITCH Monitor	L801~806	235 0049 900	BEADS INDUCTOR		
			(CD-2)	CB800,80	1 205 0708 020	18P CONN.SOCKET		
LC810	393 4139 002			CB802	205 0717 008			
LC830	393 4139 002	LCD		CB810	205 0707 021	18P CONN.BASE		
				CB830	205 0707 021	18P CONN.BASE		
				11				
				11				
	1			J			<u></u>	

GU-2402 MAIN PWB UNIT

Ref No.	Part No.	Part Name	Remarks	Ref No.	Part No.	Part Name	Remarks
SEMICO	NDUCTORS	GROUP		Λ	283 5956 006	POWERTRANS	Culmine Model
C700	263 0800 005	IC NJM78M05FA(S)		Δ	286 596 1:008	POWER TRANSPORTS	TUAK Model as
C701	263 0501 003	IC NJM79M05FA		<u> </u>	233 5954 007	POWER TRANS	Multi-Voltage Mod
	263 0695 003	IC L780S05		Δ	212 4698 008	VOLTAGE SELECTOR	Multi-Voltage Mod
IC702							
IC703	262 1479 005	IC M5M34051P					
IC710	268 0076 902	PROTECTOR ICP-N38		-			
	268 0075 903	PROTECTOR ICP-N25	A COLUMN A MARKET				
IC713~715	268 0078 900	PROTECTOR ICP-N75	Multi- Voltage Model				
TR710,711	274 0160 907	Transistor 2SD2144STPU				V.	
TR720,721	274 0160 907	Transistor 2SD2144STPU				Sign of the state	
D700	276 0603 004	Diode MA750					
D702,703	276 0603 004	Diode MA750					
D704~707	276 0553 905	Diode 1SR35-200A					
	276 0432 903	Diode 1SS270A					
D/00~/13	270 0432 303						
LE700	393 9462 017	LED SLR-40VC3F (RED)				• .	
RESIST	OR (Not inclu	⊥ uded Carbon Film ±5% 1	/4w)				
	TORS GROU		OF OANH OCCOMO (ONE)				
C701	254 4255 720	Electrolytic 6800µF/16V	CE04W1C682MC(SME)				
C702,703	254 4255 717	Electrolytic 4700µF/16V	CE04W1C472MC(SME)				
C706	254 4254 941	Electrolytic 100µF/16V	CE04W1C101MT(SME)				
C708	253 9036 909	Ceramic 0.1µF/25V	CK45=1E104Z				
C710,711	253 4538 949	Ceramic 100pF/50V	CC45SL1H101J				
C712	253 9036 909	Ceramic 0.1µF/25V	CK45=1E104Z				
C720,721	253 4538 949	Ceramic 100pF/50V	CC45SL1H101J				
C722	253 9036 909	Ceramic 0.1μF/25V	CK45=1E104Z				
OTHER	S PARTS GR	OUP					
L701~706	235 0049 900	BEADS INDUCTOR					
		TACT SWITCH(LONG ST)					
	212 4763 904						
SW702 \F700	212 1039 000 206 1039 018	1P PUSH SWITCH	U.S.A., Canada Model				
M=700		FUSE 0.16A	Europe, U.K. Model				
¥[700	206 1015 003	FUSE 0.5A	Multi-Voltage Mödel				
.	202 0040 908		477-544				
CB700	205 0321 054	5P CONN.BASE(RED)					
	205 058 001	2P VALCONN BASE					
A THE RESIDENCE OF THE PARTY OF	205 0190 052	5P NH CONN.BASE		11			
CB704		8P MINI DIN CONN.BASE					
CB705	205 0717 008						
CB710	205 0668 047	21P FFC CONN.BASE					
CB711	204 8373 001	2P PIN JACK					
CB720	205 0668 047	21P FFC CONN.BASE					
CB721	204 8373 001	2P PIN JACK					
CC700	203 8196 034	5P KR-DS CONN.CORD					
CC706	203 4853 001	3P DS-DS CONN.CORD					
Δ	206 2086 002	ACCORD W/GONN	U.S.A., Canada Model				
Ā.	206 2088 009		Europe Dik Model				
	206 2030 001		Ulk Wodel				
A COLUMN			Malita Waltago (MCC)				
Δ A	200 200 200		SERVICE DESCRIPTION OF THE PROPERTY OF THE PRO		1		
A	206 2000 (000)		spilis A. Johnson Model				
A A	206 2088 000	POWER TRANS	USA Ganada Model				

DN-2000F

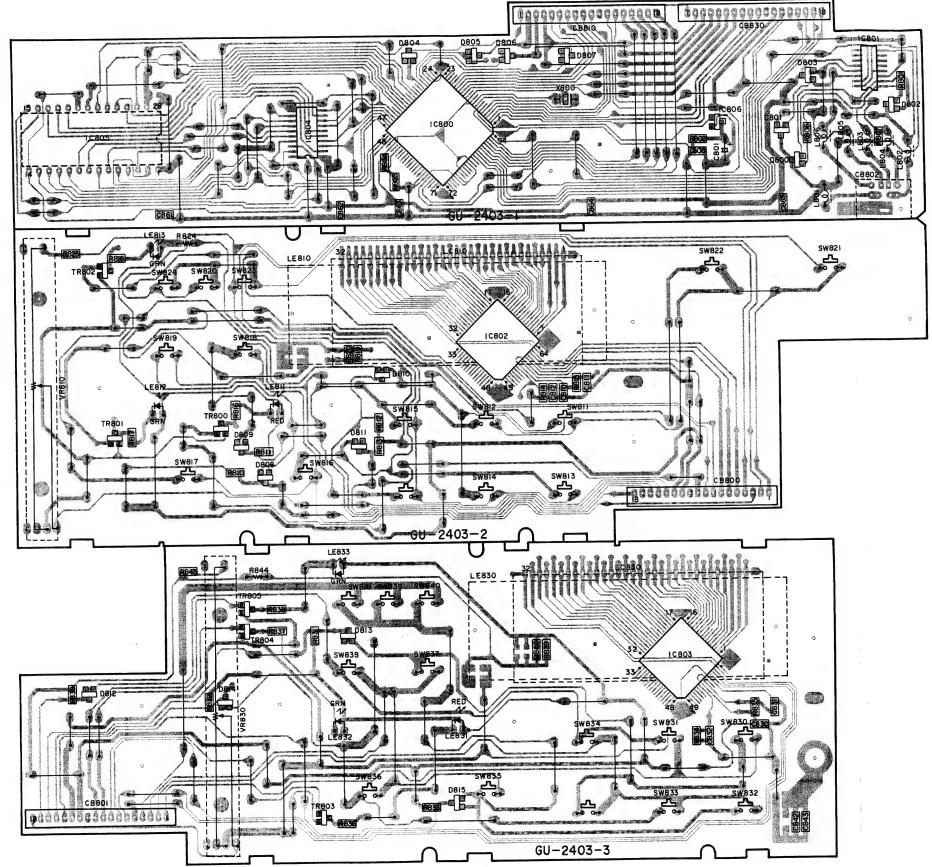
33

GU-2401 MECHA PWB UNIT

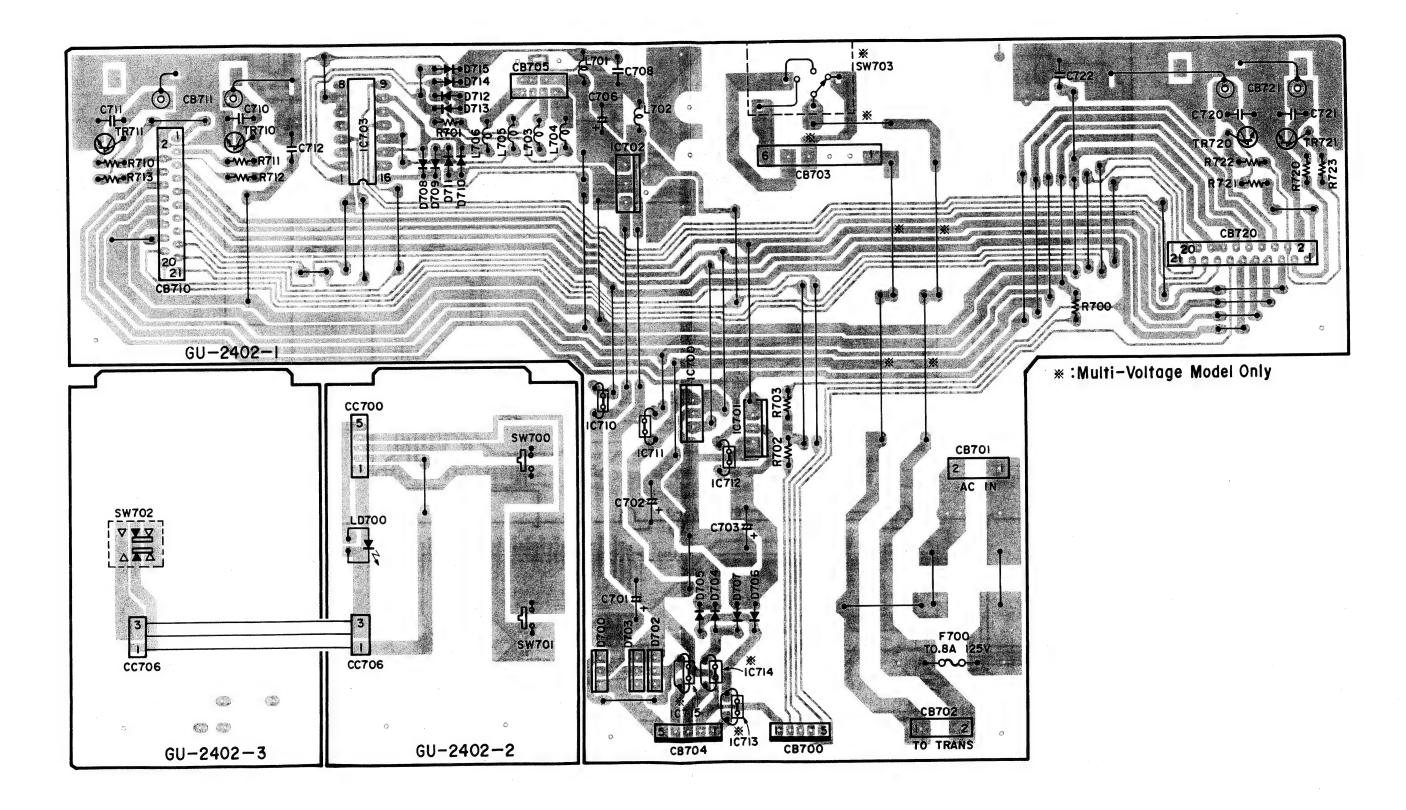
Ref No.	Part No.	Part Name	Remarks	Ref No.	Part No.	Part Name	Remarks
SEMICO	NDUCTORS	GROUP		R023	247 0012 930	Chip 110Kohm 1/10W	RM73B114J
IC001	262 1342 006	IC CXA1372Q(48PQFP)		R024,025	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
IC002	262 1514 009	IC CXD2500AQ		R026	247 0011 960	Chip 56Kchm 1/10W	RM73B563J
IC003	262 1344 907	IC SN74LS624NSR		R027	247 0011 928	Chip 39Kohm 1/10W	RM73B393J
IC003	263 0615 902	IC BA15218F		R028	247 0009 956	Chip 7.5Kohm 1/10W	RM73B752J
IC004,003	263 0805 903	IC BA6296FP		R030	247 0012 927	Chip 100Kohm 1/10W	RM73B104J
IC008		IC TC74HCU04AF		R031	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
IC200	262 1205 907 262 1473 001	IC UPD78233GJ-5BG	U.S.A. Mode Serial No.~620	R034	247 0012 943	Chip 120Kohm 1/10W	RM73B124J
10200	202 14/3 001	IC 0FD/0233G3-3BG	Europe Model Selial No.~881	R038	247 0012 927	Chip 100Kohm 1/10W	RM73B104J
			No.886~950	R039	247 0012 914	Chip 91Kohm 1/10W	RM73B913J
			U.K. Model Serial No.~300	R040	247 0011 944	Chip 47Kohm 1/10W	RM73B473J
			Canada Model Serial NoI30	R043	247 0011 986	Chip 68Kohm 1/10W	RM73B683J
				R044	247 0009 969	Chip 8.2Kohm 1/10W	RM73B822J
			Multi-Voltage Model	R045	247 0014 925	Chip 680Kohm 1/10W	RM73B684J
			Serial No.~100	R046	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
IC200	262 1690 004	IC μPD78234GJ-515	U.S.A. Model Serial No.621~	R047	247 0003 303	Chip 120Kohm 1/10W	RM73B124J
		-5BG			247 0012 945	Chip 10Kohm 1/10W	RM73B103J
			Europe Model Serial No.882~885	R050,051		•	RM73B473J
			No.951~	R052	247 0011 944	Chip 47Kohm 1/10W	
	,		U.K. Model Serial No.301~	R053	247 0009 956	Chip 7.5Kohm 1/10W	RM73B752J
			Canada Model Serial No.131~	R054	247 0008 931	Chip 2.4Kohm 1/10W	RM73B242J
			Multi-Voltage Model	R055	247 0011 944	Chip 47Kohm 1/10W	RM73B473J
			Serial No.101~	R056	247 0011 944	Chip 47Kohm 1/10W	RM73B473J
IC201	262 1474 000	IC UPD6381GF		R057	247 0012 914	Chip 91Kohm 1/10W	RM73B913J
IC203	262 1615 908	IC V53C104BK		R059	247 0005 989	Chip 220ohm 1/10W	RM73B221J
IC204	262 0943 901	IC HD74HC373FP-TL	U.S.A. Model Serial No.~620	R060	247 0009 901	Chip 4.7Kohm 1/10W	RM73B472J
			Europe Model Serial No.~881	R061	247 0006 962	Chip 470ohm 1/10W	RM73B471J
			No.886~950	R062	247 0011 902	Chip 33Kohm 1/10W	RM73B333J
			U.K. Model Serial No.~300	R063	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
			Canada Model Serial No.~I30	R064	247 0008 960	Chip 3.3Kohm 1/10W	RM73B332J
			Multi-Voltage Model	R065	247 0009 943	Chip 6.8Kohm 1/10W	RM73B682J
			Serial No.~100	R066	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
			00112111011100	R067	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
IC205	205 0488 010	IC 28P IC SOCKET	U.S.A. Model Serial No.~620	R068	247 0010 929	Chip 15Kohm 1/10W	RM73B153J
10205	GEN 2172	MECHA ROM SUB Ass'y		R069	247 0010 916	Chip 13Kohm 1/10W	RM73B133J
	GEN 2172	INIECHA NOM 300 ASS Y	No.886~950	R079	244 2051 945	Metallic 1chm 1W	RS14B3A010JNB ST(S)
			U.K. Model Serial No.~300	R080~083	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
				R084	247 0009 985	Chip 10Kohm 1/10W	
			Canada Model Serial No.~I30				U.S.A. Model Serial No.~620
			Multi-Voltage Model				Europe Model Serial No.~881
			Seriai NoI00				No.886~95
							U.K. Model Serial No.~300
IC300	262 1664 904	IC CXD2554M					Canada Model Serial No.~I30
IC301,302	262 1409 004	IC PCM61P-L					Multi-Voltage Model
IC303,304	263 0615 902	IC BA15218F	l l				Serial No.~100
IC500	262 1647 905	IC MN1382-S(TX)		Bann	247 0000 005	Chin 10Kohm 1/10M	
				R200	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
TR070	274 0036 905	Transistor 2SD468(C)TF		R202	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
TR071	272 0025 907	Transistor 2SB562(C)TF		R203	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
TR300	269 0083 901	Transistor DTA114EK		R205	247 0009 985	Chip 10Kohm 1/10W	RM73B103J
TR301	269 0082 902	Transistor DTC114EK		R250	247 0008 902	Chip 1.8Kohm 1/10W	RM73B182J
				R303	247 0018 905	Chip Oohm Jumper	RM73B0R0K
D400	276 0533 909	Diode MA3047-TX		R304	247 0007 945	Chip 1Kohm 1/10W	RM73B102J
				R305,306	247 0007 945	Chip 1Kohm 1/10W	RM73B102J
				R310	247 0011 944	Chip 47Kohm 1/10W	RM73B473J
RESIST	ORS GROUP	(Not included Carb	on Film ±5% 1/4W)	R311	247 0014 967	Chip 1Mohm 1/10W	RM73B105J
R020	247 0010 987	Chip 27Kohm 1/10W	RM73B273J	R312	247 0013 984	Chip 470Kohm 1/10W	RM73B474J
R021	247 0012 927	Chip 100Kohm 1/10W	RM73B104J	R313	247 0012 998	Chip 200Kohm 1/10W	RM73B204J
110-				0044	047 0000 000	Chin 11 Kahm 1/10W	DM700 4401
R022	247 0009 985	Chip 10Kohm 1/10W	RM73B103J	R314	247 0009 998	Chip 11Kohm 1/10W	RM73B113J

R316	Ref No.	Part No.	Part Name	Remarks	Ref No.	Part No.	Part Name	Remarks
Sept	R315	247 0009 927	Chip 5.6Kohm 1/10W	RM73B562J	C029	257 0004 961	Ceramic-chip 100pF/50V	CC73SL1H101J
247 0019 590 Chg 247 0019 540 Chg 247 0019 550 Chg 247 00	316	247 0009 998	Chip 11Kohm 1/10W	RM73B113J	C030,031	257 0012 966	Ceramic-chip 0.01µF/50V	CK73F1H103Z
247 0019 594 Chip 36/chm 1/10W RM738-473	317	247 0010 945	Chip 18Kohm 1/10W	RM73B183J	C032	254 4305 926	Electrolytic 0.22µF/50V	CE04W1HR22M(SRE)
227 0011 947 Chg Mix79m F133 Chg F126m F100 F126m Chg F126m F100 Chg F126m Chg C	118	247 0010 958	Chip 20Kohm 1/10W	RM73B203J	C033	257 1011 966	Ceramic-chip 0.033µF/50V	CK73B1H333K
327 0014 987 0.00 987 0.00 947 0.00	319	247 0010 990	Chip 30Kohm 1/10W	RM73B303J	C040,041	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1E104Z
227 0019 984 Chip 4706chm 11/0W RM738-474 RM738-204J Code 277 0019 985 Chip 1106chm 11/0W RM738-134 Code 277 0019 985 Code 277 0019	330	247 0011 944	Chip 47Kohm 1/10W	RM73B473J	C044	257 0010 900	Ceramic-chip 0.01µF/50V	CK73B1H103K
247 0019 987 Chip 1006mm 11/10W RM789-103.1 Co80 257 0019 981 Cearmic-chip 10.04/F679 CE94WH102M/MOR Co80 257 0019 981 Cearmic-chip 10.04/F679 CE94WH102M/MOR Co80 257 0019 981 Cearmic-chip 10.04/F679 CE94WH102M/MOR Co80 257 0019 981 Cearmic-chip 10.04/F679 CC73S.LH1801. CC80 257 0019 981 Cearmic-chip 10.04/F679 CC73S.LH1801. CC80 257 0019 981 Cearmic-chip 10.04/F679 CC73S.LH1801. CC80 257 0019 981 CC80	31	247 0014 967	Chip 1Mohm 1/10W	RM73B105J	C045	254 4299 964	Electrolycic 47µF/16V	CE04W1C470M(SRE)
247 0009 998 Chp 11Kohm 1/10W	32	247 0013 984	Chip 470Kohm 1/10W	RM73B474J	C046	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1E104Z
247 0009 927 Chg 15,656cm 11,00W RM738—133 Chg 12,000 937 Chg 11,00cm 11,00W RM738—133 Chg 12,000 937 Chg 11,00cm 11,00W RM738—133 Chg 12,000 937 Chg 12,00cm 11,00W RM738—133 Chg 12,00cm 11,00W RM738—133 Chg 12,00cm 11,00cm 11,00W RM738—134 Chg 12,00cm 11,00cm 1	333	247 0012 998	Chip 200Kohm 1/10W	RM73B204J	C051	257 0004 961	Ceramic-chip 100μF/50V	CC73SL1H101J
Content	334	247 0009 998	Chip 11Kohm 1/10W	RM73B113J	C060	254 4305 926	Electrolytic 0.22µF/50V	CE04W1HR22M(SRE)
247 0010 945 Chip 18Kohm 1/10W RM73B-183J C083 257 0007 942 Ceramic-chip 1500pF80V C073SL1H300 (2004) 247 0010 950 Chip 38Kohm 1/10W RM73B-103J C086 257 0001 951 Ceramic-chip 58pF80V C073SL1H300 (2004) 247 0007 945 Chip 10Kohm 1/10W RM73B-103J C086 257 0001 951 Ceramic-chip 58pF80V C073SL1H300 (2004) 247 0010 980 Chip 38Kohm 1/10W RM73B-103J C086 257 0001 951 Ceramic-chip 0.1µF25V CK73Fl1104Z C073SL 247 0002 992 Chip 10Kohm 1/10W RM73B-103J C086 257 0001 951 Ceramic-chip 0.1µF25V CK73Fl1104Z C085 257 0001 951 Ceramic-chip 0.1µF25V C	335	247 0009 927	Chip 5.6Kohm 1/10W	RM73B562J	C061	257 0002 989	Ceramic-chip 18pF/50V	CC73SL1H180J
247 0010 958 247 0010 958 Chip 20Kohm 1/10W RM738-203J C066 257 0010 951 Ceramic-chip 3pF50V CC73SLIH3R0	36	247 0009 998	Chip 11Kohm 1/10W	RM73B113J	C062	257 1013 951	Ceramic-chip 0.047µF/25V	CK73B1E473K
247 0019 93	37	247 0010 945	Chip 18Kohm 1/10W	RM73B183J	C063	257 0007 942	Ceramic-chip 1500pF/50V	CC73SL1H152J
247 0007 945 Chip Kohm 1/10W RM738-102J C066 254 4300 963 Electrolytic 100µF6.3V CCP4WB107MB-323Z C0707 945 Coffee C	338	247 0010 958	Chip 20Kohm 1/10W	RM73B203J	C064	257 0001 951	Ceramic-chip 3pF/50V	CC73SL1H3R0C
247 0008 960 Chip 3 3Kohm 1/10W RM738-332J C087-069 257 0014 935 Ceramic-dip 0.1μF225V CK73F1E104Z	339	247 0010 990	Chip 30Kohm 1/10W	RM73B303J	C065	257 0001 977	Ceramic-chip 5pF/50V	CC73SLIH5R0C
22 247 0012 929 Chip 150Kohm 1/10W RM73B-154J C200,201 257 0003 914 Caramic-chip 0.1µF25V CX73F1104Z C205 257 0014 935 Caramic-chip 0.1µF25V CX73F1104Z C202 247 0003 915 Chip 10Kohm 1/10W RM73B-104J C302 257 0014 935 Caramic-chip 0.1µF25V CX73F1104Z C202 247 0003 915 Chip 10Kohm 1/10W RM73B-104J C302 257 0014 935 Caramic-chip 0.1µF25V CX73F1104Z C202 247 0006 917 Chip 300ohm 1/10W RM73B-104J C302 257 0014 935 Caramic-chip 0.1µF25V CX73F1104Z C303 257 0014 935 Caramic-chip 0.1µF25V CX73F1104Z	50	247 0007 945	Chip 1Kohm 1/10W	RM73B102J	C066	254 4300 963	Electrolycic 100µF/6.3V	CE04W0J1O1M(SRE)
247 0012 989 Chip 150kohm 1/10W	1	247 0008 960	1 '	RM73B332J	C067~069	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1E104Z
0.0.501 247 0011 902 Chip 30Kohm 1/10W RM73B-103J C200.201 257 0014 935 Ceramic-chip 0.1µF25V CK73F1104Z CX73F1104Z				RM73B154J	C104	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1E104Z
22.503 247 0009 985 Chip 10Kohm 1/10W RM73B-103J C202,203 257 0014 935 Ceramic-chip 0.1µF25V CK73F1104Z C205 257 0014 935 Ceramic-chip 0.1µF25V CK73F1104Z C205 257 0014 935 Ceramic-chip 0.1µF25V CK73F1104Z C205 C205,207 C254 4300 983 Electrolytic 100µF6.3V CE04W0101M C253 C257 0014 935 Ceramic-chip 0.1µF25V CK73F1104Z C253 C257 0014 935 C25			Chip 33Kohm 1/10W		C200,201	257 0003 904	Ceramic-chip 22pF/50V	CC73SLIH220J
247 0012 927 Chip 100Kohm 1/10W RM73B-104J C206.207 254 4300 938 Electrolytic 100μFi6.3V CE04W010 10M C230 257 0014 935 Ceramic-chip 0.1μFi25V CK73F1E104Z C301 257 0014 935 Ceramic-chip 0.1μFi25V CK73F1E104Z C301 257 0004 938 Ceramic-chip 0.1μFi25V CK73F1E104Z C301 C302 C301 C303 C37 0014 935 Ceramic-chip 0.1μFi25V CK73F1E104Z C301 C303 C303 C37 0014 935 Ceramic-chip 0.1μFi25V CK73F1E104Z C301 C303 C303 C37 0014 935 Ceramic-chip 0.1μFi25V CK73F1E104Z C301 C303 C303 C37 0014 935 Ceramic-chip 0.1μFi25V CK73F1E104Z C301 C303 C303 C37 0014 935 Ceramic-chip 0.1μFi25V CK73F1E104Z C301 C303 C303 C37 0014 935 Ceramic-chip 0.1μFi25V CK73F1E104Z C303 C303 C37 0005 931 Ceramic-chip 0.1μFi25V CK73F1E104Z C303 C303 C37 0005 931 C37 0005 931 C47 0005		247 0009 985	Chip 10Kohm 1/10W	RM73B103J	C202,203	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1E104Z
247 0009 985 Chip 10Kohm 1/10W RM73B-103J C253 254 4300 934 Electrolytic 22μFi6.3V CE04W01/220M C308 247 0012 927 Chip 10Kohm 1/10W RM73B-104J C301 254 4300 963 Electrolytic 10μFi6.3V CE04W01 01M C73Fi110-42 C301 247 0009 991 Chip 10Kohm 1/10W RM73B-104J C302 257 0014 935 Ceramic-chip 0.1μFi25V CK73Fi110-42 C301 247 0009 995 Chip 10Kohm 1/10W RM73B-104J C302 257 0014 935 Electrolytic 10μFi6.3V CE04W01 01M C47 0008 915 Chip 2Kohm 1/10W RM73B-202J C304 257 0014 935 Electrolytic 10μFi6.3V CE04W01 01M C47 0008 915 Chip 2Kohm 1/10W RM73B-104J C305,3306 257 0014 935 Ceramic-chip 0.1μFi25V CK73Fi110-42 C307 257 0014 935 Ceramic-chip 0.1μFi25V CK73Fi110-42 C307 257 0014 935 Ceramic-chip 0.1μFi25V CK73Fi110-42 C307 257 0014 935 Ceramic-chip 0.1μFi25V CK73Fi110-42 C308,3300 C308,3300 C37 0014 935 Ceramic-chip 0.1μFi25V CK73Fi110-42 C308,3300 C308,3300 C37 0014 935 Ceramic-chip 0.1μFi25V CK73Fi110-42 C308,3300 C308,3300 C37 0014 935 Ceramic-chip 0.1μFi25V CK73Fi110-42 C338 C33	.)	247 0012 927	Chip 100Kohm 1/10W	RM73B104J	C205	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1E104Z
247 0012 927 Chip 100Kohm 1/10W RM73B-104J Caramic-chip 0.1µF25V CAR3F1E104Z Caramic-chip 0.047µF25V Caramic-chip 0.047µF25V CAR3F1E104Z Caramic-chip 0.047µF25V Caramic-chip 0.047µF25V Caramic-chip 0.047µF25V CAR3F1E104Z Caramic-chip 0.047µF25V Caramic	01,602	247 0012 927	Chip 100Kohm 1/10W	RM73B104J	C206,207	254 4300 963	Electrolytic 100μF/6.3V	CE04W0J1O1M(SRE)
247 0009 901 Chip 4.7Kohm 1/10W RM73B-472J Chip 100Kohm 1/10W RM73B-103J Chip 247 0009 998 Chip 247 0009 915 Chip 245 4000 998 Chip 245 4000 998 Chip 245 4000 998 Chip 245 4000 915 Chip 245 4000 915 Chip 245 4000 915 Chip 245 4000 915 Chip 245 4000 917 Chip 3000hm 1/10W RM73B-202J Chip 3000hm 1/10W RM73B-301J Casamic-chip 0.1µF25V CK73F16104Z Chip 1006hm 1/10W RM73B-104J Casamic-chip 0.1µF25V CK73F16104Z Casamic-chip 0.0µF650V Casamic-chip 0.0µF650V Casamic-chip 0.0µF650V Casamic-chip 0.0µF650V Casamic-chip 0.0µF650V CASBH103K Casamic-chip 0.0µF650V Casamic-chip 0.	03	247 0009 985	Chip 10Kohm 1/10W	RM73B103J	C253	254 4300 934	Electrolytic 22µF/6.3V	CE04W0J220M(SRE)
247 0012 927 Chip 100Kohm 1/10W RM73B-104J C302 257 0014 935 Ceramic-chip 0.1μF/25V CK73F1104Z C502 C504W0H 101M C47 0005 936 C604W1H 101W C619 2K47 0005 917 C619 000chm 1/10W RM73B-104J C305 C305 C305 C306 C306 C307 C308 C	07	247 0012 927	Chip 100Kohm 1/10W	RM73B104J	C300	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1E1 O 4Z
Caramic-chip 0.01 μF/25V CAY3F1E104Z Caramic-chip 0.1 μF/25V CAY3F1E104Z Ca	08	247 0009 901	Chip 4.7Kohm 1/10W	RM73B472J	C301	254 4300 963	Electrolytic 100μF/6.3V	CE04W0J1O1M(SRE)
247 0009 915 Chip 2Kohm 1/10W RM73B-202J C304 257 0014 935 Ceramic-chip 0.1μF/25V CK73F16104Z C305,306 257 0014 935 Caramic-chip 0.1μF/25V CK73F16104Z C305,306 C313 C37 0005 931 C310,311 C37 0005 931 C310,311 C37 0005 931 C310 C3	:09	247 0012 927	Chip 100Kohm 1/10W	RM73B104J	C302	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1[1O4Z
247 0006 917 Chip 300ohm 1/10W RM73B-301J C305,306 257 0014 935 Ceramic-chip 0.1μF/25V CK73F1f104Z C308,309 C37 0014 935 Ceramic-chip 0.1μF/25V CK73F1f104Z C308,309 C37 0014 935 Ceramic-chip 0.1μF/25V CK73F1f104Z C308,309 C313,11 257 0014 935 Ceramic-chip 0.1μF/25V CK73F1f104Z C308,309 C313,11 257 0014 935 Ceramic-chip 0.1μF/25V CK73F1f104Z C308,309 C313,11 C37 0014 935 Ceramic-chip 0.1μF/25V CK73F1f104Z C308,309 C313,11 C37 0014 935 Ceramic-chip 0.1μF/25V CK73F1f104Z C313,11 C37 0014 935 Ceramic-chip 1.00pF/50V C73SLH 120. C314 C37 0002 932 Ceramic-chip 0.1μF/25V C73SLH 120. C314 C37 0002 932 Ceramic-chip 0.1μF/25V CK73F1f104Z C314 C37 0002 932 Ceramic-chip 0.1μF/25V CK73F1f104Z C314 C37 0002 932 Ceramic-chip 0.1μF/25V CK73F1f104Z C333 C37 0002 932 Ceramic-chip 0.1μF/25V CK73F1f104Z C333 C37 0002 932 Ceramic-chip 0.1μF/25V CK73F1f104Z C334 C37 0002 932 Ceramic-chip 0.1μF/25V CK73F1f104Z C334 C37 0002 932 Ceramic-chip 0.01μF/50V C73SLH 120. C334 C37 0002 932 Ceramic-chip 0.01μF/50V CK73B1H33K C334 C37 0002 932 Ceramic-chip 0.01μF/50V CK73B1H33K C334 C37 0002 932 Ceramic-chip 0.01μF/50V CC73SLH 200. C73SLH 200. C335 C33 C37 0003 937 Ceramic-chip 0.047μF/25V CK73B1E473K C37 0003 937 Ceramic-chip 0.047μF/25V CK73B1E473K C37 0003 934 Ceramic-chip 0.047μF/25V CK73B1E473K C27 1013 935 Ceramic-chip 0.047μF/25V CK73B1E43K C37 0003 934 Ceramic-chip 0.047μF/25V CK73B1E3K C38 0000 C27 00000 C27 0000 934 Ceramic-chip 0.047μF/25V CK73B1E3K C38 0000 C27 0000 934 Ceramic-chip 0.047μF/25V CK73B1E3K C38 0000 C38 00	00	247 0009 998	Chip 11Kohm 1/10W	RM73B113J	C303	254 4300 963	Electrolytic 100μF/6.3V	CE04W0J1O1M(SRE)
247 0007 945 Chip 1Kohm 1/10W RM73B-102J C307 257 0014 935 Ceramic-chip 0.1µF/25V CK73F1t104Z C31001,002 211 6086 903 Semi Fixed Resistor 22Kohm Semi Fixed Resistor 100Kohm V06PB104 C313 257 0007 926 Ceramic-chip 1.0µF/25V CK73F1t104Z C313 257 0007 926 Ceramic-chip 200pF/50V CC73SLH 201. C314 257 0005 931 Ceramic-chip 200pF/50V CC73SLH 202. C314 257 0007 926 Ceramic-chip 200pF/50V CC73SLH 202. C314 257 0007 926 Ceramic-chip 200pF/50V CC73SLH 203. C315 257 0014 935 Ceramic-chip 0.1µF/25V CK73F1t104Z C314 257 0007 926 Ceramic-chip 200pF/50V CC73SLH 203. C315 257 0014 935 Ceramic-chip 0.1µF/25V CK73F1t104Z C314 257 0007 926 Ceramic-chip 200pF/50V CC73SLH 203. C315 257 0014 935 Ceramic-chip 0.1µF/25V CK73F1t104Z C315 257 0014 935 Ceramic-chip 200pF/50V CC73SLH 203. C315 257 0014 935 Ceramic-chip 200pF/50V CC73SLH 203. C315 257 0014 935 Ceramic-chip 200pF/50V CC73SLH 203. C316 257 0009 932 Ceramic-chip 0.1µF/25V CK73B1H103K C332 257 0007 926 Ceramic-chip 200pF/50V CC73SLH 203. C332 257 0004 961 Ceramic-chip 300pF/50V CK73B1H332K C57 0004 961 Ceramic-chip 500pF/50V CK73B1E33K C57 0004 961 Ceramic-chip 0.047µF/25V CK73B1E33K C57 0004 961 Ceramic-chip 0.047µF/25V CK73B1E33K C57 0004 961 Ceramic-chip 0.082µF/25V CK73B1E33K C57 0004 961 Ceramic-chip 0.082	01	247 0008 915	Chip 2Kohm 1/10W	RM73B202J	C304	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1[1O4Z
Caramic Chip 100Kohm 1/10W RM73B-104J Caramic Chip 100Kohm 1/10W RM73B-104J Caramic Chip 100Kohm 1/10W RM73B-104J Caramic Chip 100Kohm Chip 1/10AZ Caramic C	2	247 0006 917	Chip 300ohm 1/10W	RM73B301J	C305,306	257 0014 935	Ceramic-chip 0.1μF/25V	CK73F1[1O4Z
Caramic Cara	3	247 0007 945	Chip 1Kohm 1/10W	RM73B102J	C307	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1[1O4Z
211 6086 903 Semi Fixed Resistor 22Kohm Semi Fixed Resistor 100Kohm V06PB104 C312 257 0007 926 Ceramic-chip 200pF/50V CC73SLH 201. C314 257 0002 992 Ceramic-chip 20pF/50V CC73SLH 201. C314 257 0002 992 Ceramic-chip 20pF/50V CC73SLH 201. C314 257 0002 992 Ceramic-chip 20pF/50V CC73SLH 201. C315 C314 C316	4	247 0012 927	Chip 100Kohm 1/10W	RM73B104J	C308,309	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1[1O4Z
211 6077 938 Semi Fixed Resistor 100Kohm V06PB104 C313 257 0005 931 Ceramic-chip 20pF/50V CC73SLH201. C314 257 0002 992 Ceramic-chip 0.1μF/25V CK73F1E104Z C332 257 0007 926 Ceramic-chip 0.01μF/50V CC73SLH201. C332 C37 0007 926 Ceramic-chip 20pF/50V CC73SLH201. C332 C37 0007 926 Ceramic-chip 0.01μF/50V CC73SLH201. C332 C37 0007 926 Ceramic-chip 20pF/50V CC73SLH201. C334 C37 0007 926 Ceramic-chip 20pF/50V CC73SLH201. C335 C34 4306 925 Ceramic-chip 20pF/50V CC73SLH201. C335 C34 4306 925 Ceramic-chip 20pF/50V CC73SLH201. C335 C34 4306 925 Ceramic-chip 20pF/50V CC73SLH303. C401 C37 0004 961 Ceramic-chip 20pF/50V CC73SLH303. C401 C37 0004 961 Ceramic-chip 0.047μF/25V CK73B1E473K C500~505 C57 0014 935 Ceramic-chip 0.047μF/25V CK73B1E473K C500~505 C57 1013 993 Ceramic-chip 0.047μF/25V CK73B1E473K C600 C257 1013 993 Ceramic-chip 0.047μF/25V CK73B1E32K C700 C400 C4					C310,311	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1[1O4Z
C314	01,002	211 6086 903	Semi Fixed Resistor 22Kohm	V04PB203M(RVG4M)	C312	257 0007 926	Ceramic-chip 1200pF/50V	CC73SL/H 122J
APACITORS GROUP 1 254 4430 008	300,301	211 6077 938	Semi Fixed Resistor 100Kohm	V06PB104	C313	1	Ceramic-chip 200pF/50V	CC73SLH201J
Caramic-chip 0.01 1.μF/25V CK73F1E104Z Caramic-chip 0.01 1μF/25V CK73B1H103K Caramic-chip 0.01 1μF/25V CK73B1H273K Caramic-chip 0.047 1μF/25V CK73B1H273K Caramic-chip 0.047 1μF/25V CK73B1H224K Caramic-chip 0.047 1μF/25V CK73B1	ĺ				C314	257 0002 992	Ceramic-chip 20pF/50V	CC73SLH 200J
254 4430 008 Electrolytic 1000μF/6.3V CE04W0J102M(KMG) C330,331 257 0014 935 Ceramic-chip 0.1μF/25V CK73F1E104Z C332 257 0007 926 Ceramic-chip 1200pF/50V CC73SLH 120. C73SLH 1	CADACI	TORS CROW	D		C315	254 4306 925	Electrolytic 10μF/50V	CE04W1H1 00M(SRE)
257 0014 935 Ceramic-chip 0.1μF/25V CK73F1E104Z C333 257 0005 931 Ceramic-chip 200F/50V CC73SLH 201.					C330,331	257 0014 935	Ceramic-chip 0.1µF/25V	CK73F1[1O4Z
257 0010 900 257 0010 900 Ceramic-chip 0.01μF/50V CK73B1H103K CK73B1H272K CK73B1H272K CK73B1H272K CK73B1H272K CK73B1H272K CK73B1H332K CF3 1010 941 Ceramic-chip 3300pF/50V CK73B1H332K CF3 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K CK73B1E473K CF3 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K CK73B1E473K CF3 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K CK73B1E473K CF3 1013 951 Ceramic-chip 0.047μF/25V CK73B1E420K CK73B1E473K CF3 1013 953 Ceramic-chip 0.047μF/25V CK73B1E424X CF3 1013 960 Ceramic-chip 0.033μF/50V CK73B1E823K CB001 205 0681 008 12P FFC SIDE BASE CF3 1013 960 Ceramic-chip 100pF/50V CC73SL1H101J CR002 205 0395 051 SP CONN.BASE (RED) L CF3 1013 970 Ceramic-chip 0.033μF/50V CF93A1H224J CB004 205 0702 039 21P FFC CONN.BASE (L) CF3 1013 993 Ceramic-chip 100pF/50V CC73SL1H510J CR004 205 0702 039 21P FFC CONN.BASE (L) CF3 1013 993 Ceramic-chip 100pF/50V CC73SL1H510J CR004 205 0702 039 21P FFC CONN.BASE (L) CF3 1013 993 Ceramic-chip 51pF/50V CK73B1E104K CR004 205 0702 039 21P FFC CONN.BASE (L) CF3 1013 993 Ceramic-chip 51pF/50V CK73B1E104K CR004 205 0702 039 21P FFC CONN.BASE (L) CF3 1013 993 Ceramic-chip 51pF/50V CK73B1E104K CR004 205 0702 039 21P FFC CONN.BASE (L) CF3 1013 993 Ceramic-chip 51pF/50V CK73B1E104K CR004			1 '	, ,	C332	257 0007 926	Ceramic-chip 1200pF/50V	CC73SLIH 122J
257 0009 937 Ceramic-chip 2700pF/50V CK73B1H272K C257 0010 900 Ceramic-chip 0.01μF/50V CK73B1H332K C257 1010 941 Ceramic-chip 3300pF/50V CK73B1H332K C257 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K C257 1013 993 Ceramic-chip 0.047μF/25V CK73B1E473K C257 1013 993 Ceramic-chip 0.047μF/25V CK73B1E104K C257 1013 993 Ceramic-chip 0.033μF/50V CK73B1E823K C257 1013 980 Ceramic-chip 0.033μF/50V CK73B1H333K C257 1011 966 Ceramic-chip 0.033μF/50V CK73B1H333K C257 1011 966 Ceramic-chip 0.033μF/50V CC73SL1H101J CB002 255 0881 008 12P FFC SIDE BASE CB004 255 0035 059 5P KR CONN.BASE (L) CB004 255 0035 059 5P KR CONN.BASE (L) CB004 255 0035 062 6P KR CONN.BASE (L) CB004 255 0035 062 6P KR CONN.BASE (L) CB004 257 0039 901 Ceramic-chip 0.1μF/25V CK73B1E104K CB004 250 0355 062 6P KR CONN.BASE (L) CB004 257 0039 901 Ceramic-chip 0.1μF/25V CK73B1E104K CB004 250 0355 062 6P KR CONN.BASE (L) CB004 257 0039 901 Ceramic-chip 0.1μF/25V CK73B1E104K CB004 250 0355 062 6P KR CONN.BASE (L) CB004 257 0039 901 Ceramic-chip 0.1μF/25V CK73B1E104K CB004	002	257 0014 935	Ceramic-chip 0.1µF/25V		C333	257 0005 931	1 ' '	CC73SLH 201J
257 0010 900 Ceramic-chip 0.01μF/50V CK73B1H103K CK73B1H332K CF37 1010 941 Ceramic-chip 3300pF/50V CK73B1H332K CF37 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K CF37 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K CF37 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K CK73B1E473K CEramic-chip 0.047μF/25V CK73B1E473K CK73B1E473K CEramic-chip 0.047μF/25V CK73B1E473K CK73B1E473K CEramic-chip 0.047μF/25V CK73B1E473K CK73B1E422K CK73B1E404K CEramic-chip 0.047μF/25V CK73B1E404K CK73B1E422K CK73B1E404K CEramic-chip 0.047μF/25V CK73B1E104K CEramic-chip 0.047μF/25V CK73B1E104K CEramic-chip 0.047μF/25V CK73B1E104K CEramic-chip 0.047μF/25V CK73B1E323K CEramic-chip 0.033μF/50V CK73B1E323K CEramic-chip 0.033μF/50V CK73B1H333K CB001 205 0681 008 12P FFC SIDE BASE CB002 205 0395 051 SP CONN.BASE (L) CB004 205 0702 039 21P FFC CONN.BASE (L) CP37 1013 993 Ceramic-chip 0.1μF/25V CK73B1E104K CR004 205 0702 039 21P FFC CONN.BASE (L) CP37 1013 993 Ceramic-chip 0.1μF/25V CK73B1E104K CM04 CR004			, ,		C334	257 0002 992	Ceramic-chip 20pF/50V	CC73SLH 200J
257 1010 941 Ceramic-chip 3300pF/50V CK73B1H332K C700	1				1 1	254 4306 925		CE04W1H1 OOM(SRE)
257 0006 943 Ceramic-chip 560pF/50V CC73SL1H561J C700 257 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K C673B1E473K C673B1E					C401	257 0004 961	' '	CC73SLH 101J
015					C500~505	257 0014 935	Ceramic-chip 0.1µF/25V	
Ceramic-chip 0.1μF/25V CK73B1E104K CK73B1E473K CEramic-chip 0.047μF/25V CK73B1E473K CCFamic-chip 0.200pF/50V CK73B1E422K CK73B1E422K CK73B1E422K CK73B1E422K CEramic-chip 0.1μF/25V CK73B1E823K CEramic-chip 0.082μF/25V CK73B1E823K CEramic-chip 0.082μF/25V CK73B1E823K CEramic-chip 0.033μF/50V CK73B1H333K CEramic-chip 0.033μF/50V CK73B1H333K CEramic-chip 0.033μF/50V CC73SL1H101J CE024 254 4304 930 Electrolytic 6.8μF/35V CE04W1V6R8M(SRE) C025 257 0003 991 Ceramic-chip 51pF/50V CC73SL1H510J CE026 257 0003 991 Ceramic-chip 51pF/50V CC73SL1H510J CE027 CE73B1E104K CE73B1E10	1		· ·		C700	257 0013 907	Ceramic-chip 0.047µF/50V	CK73F1 14 7 3 Z
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017 257 1013 951 Ceramic-chip 0.047μF/25V CK73B1E473K CY3B1E473K CF73B1E473K CF73B1E422K CF73B1E422K CF73B1E422K CF73B1E422K CF73B1E422K CF73B1E424K X200 399 0038 008 CERAMIC VIBRATOR CF712.0I 399 0174 001 CRYSTAL 24.576Miz CF73B1E433K CF73B1E43A1 CF73B1A13A1 CF73B1A1A1 CF73B1A1A1 CF73B1A1A1A1 CF73B1A1A1A1 CF73B1A1A1A1 CF73B1A1A1A1 CF73B1	1				OTHER	S PARTS GRO	OUP	<u> </u>
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21 257 1011 966 Ceramic-chip 0.033μF/50V CK73B1H333K CB001 205 0681 008 12P FFC SIDE BASE 257 0004 961 Ceramic-chip 100pF/50V CC73SL1H101J CB002 205 0395 051 5P CONN.BASE (RED) L 254 4304 930 Electrolytic 6.8μF/35V CE04W1V6R8M(SRE) CB003 205 0355 059 5P KR CONN.BASE(L) 256 1035 910 Metallize 0.22μF/50V CF93A1H224J CB004 205 0702 039 21P FFC CONN.BASE(L) 257 0003 991 Ceramic-chip 51pF/50V CC73SL1H510J TP001 205 0355 062 6P KR CONN. BASE(L) 257 1013 993 Ceramic-chip 0.1μF/25V CK73B1E104K 009 0079 009 21P FFC	1				1 1			
22 257 0004 961 Ceramic-chip 100pF/50V CC73SL1H101J CB002 205 0395 051 5P CONN.BASE (RED) L 24 254 4304 930 Electrolytic 6.8μF/35V CE04W1V6R8M(SRE) 25 256 1035 910 Metallize 0.22μF/50V CF93A1H224J CB004 205 0702 039 21P FFC CONN.BASE(L) 26 257 0003 991 Ceramic-chip 51pF/50V CC73SL1H510J TP001 205 0355 062 6P KR CONN. BASE(L) 27 257 1013 993 Ceramic-chip 0.1μF/25V CK73B1E104K 009 0079 009 21P FFC	1				1 1			24.5/6MIZ
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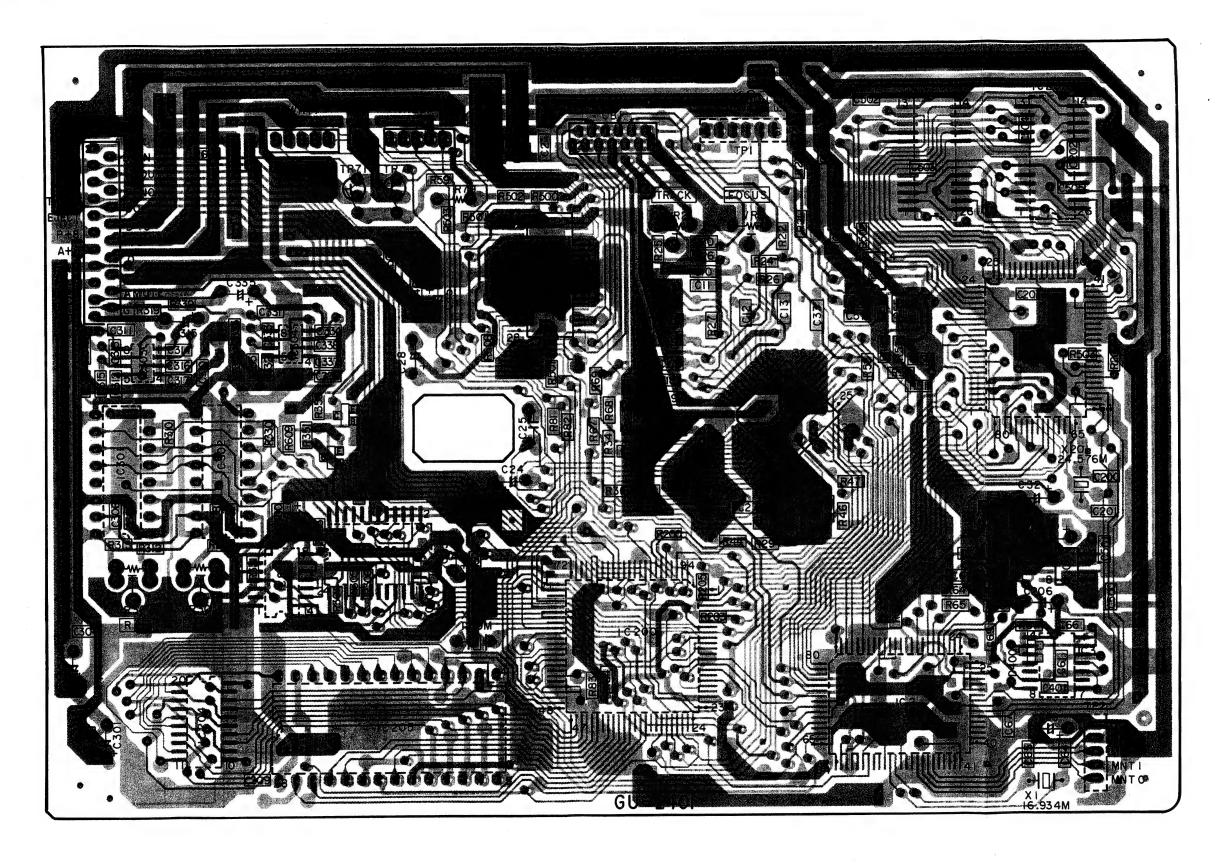
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GU-2402 MAIN UNIT



GU-2401 MECHA UNIT

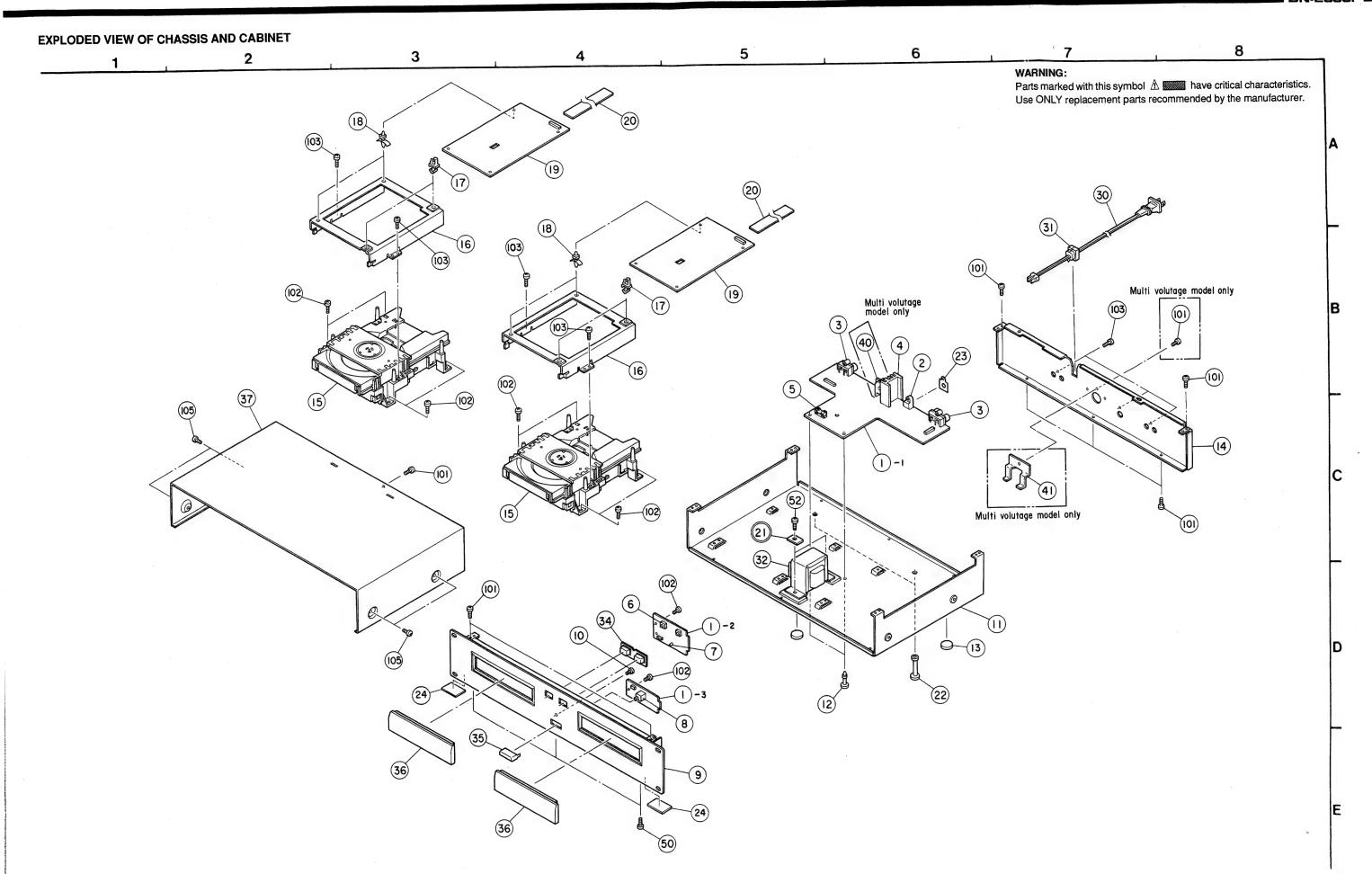


PARTS LIST OF EXPLODED VIEW

PACKING AND ACCESSORIES (not included EXPLODED VIEW)

			,		,	(not in
Re	f. No.	Part No.	Part Name	Remarks	Q'ty	Ref. No
•	1	GU-2402	MAIN PWB UNIT		1	301
	1-1	GU-2402-1	MAIN PWB UNIT		1	302
	1-2	GU-2402-2	PANEL PWB UNIT		1	
	1-3	GU-2402-3	PANEL PWB UNIT		2	
	2	205 0717 008	8P MINI DIN CON. BASE 2P PIN JACK		1	202
•	3 4	204 8373 001 417 0462 105	HEAT SINK		2	303
		MOTERAL CONTRACTOR		Property and season by the		304
		ala soca free		inger (glandish)		305
in.		CHANGE TO SERVICE STREET		Malil Malingan Majariji kasa c		306
	6 7	212 4763 904 393 9462 017	TACT SWITCH (LONG ST) LED (RED)	SLR-40VC3F	2	307 308
	8	212 1039 000	1P PUSH SWITCH	3617407031		309
•	9	144 2189 106	FRONT PANEL Ass'y			310
•	10	146 1371 005	LED WINDOW		1	311
•	11	411 1422 201	CHASSIS		1	312
•	12	499 0074 008	LOCKING CARD SPACER		2	313
	13	461 0706 101	FOOT SHEET		2	314
•	14	105 1029 000	BACK PANEL	U.S.A. And Canada Model	1	315
•		105 1029 123	BACK PANEL	Europe Model	1	316
•		105 1029 123	BACK PANEL	U.K. Model	1	317
•		105 1029 110	BACK PANEL	Multi-Voltage Model	1	318
9	15	FG- 50	CD MECHA.UNIT		2	
9	16	412 3495 200	P.W.B. BASE	,	2	
	17	499 0063 006	PIERCE HOLD		4	
	18	449 0033 049	LOCKING CARD SPACER		4	
,	19 20	GU- 2401 009 0079 009	MECHA PWB UNIT 21P FFC		1 2	
	21	WA- 0120 H	WASHER		2	
)	22	449 0077 005	CARD SPACER		2	
)	23	412 3555 108	EARTH PLATE		1	
	24	461 0740 002	SHEET		2	
	25	_				
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8.46	33		N 233 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1			
	34	119 0069 109	RUBBER BUTTON (B)		1	
	35	113 1357 207	POWER SW.BUTTON		1	
)	36	146 9238 140	LOADER PANEL		2	
)	37	102 0425 101	TOP COVER		1	
			STOKED ZATIFOV	A RESOLUTION CONTRACTOR		
•	41	411 1143 001	SELECTOR BRACKET	Multi-Voltage Model	1	
S	CREW	/S			·	
	101	473 7015 005	TAPPING SCREW 3×6 (S)	Black	11	
	102	473 7002 005	TAPPING SCREW 3×6 (S)		10	
	103	473 7508 017	TAPPING SCREW 3×10(P)	Black	7	-
	104	473 7004 003	TAPPING SCREW 4×8 (S)		2	
	105	477 0263 005	3P SWELLING SCREW	Black	4	● Pa
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						0

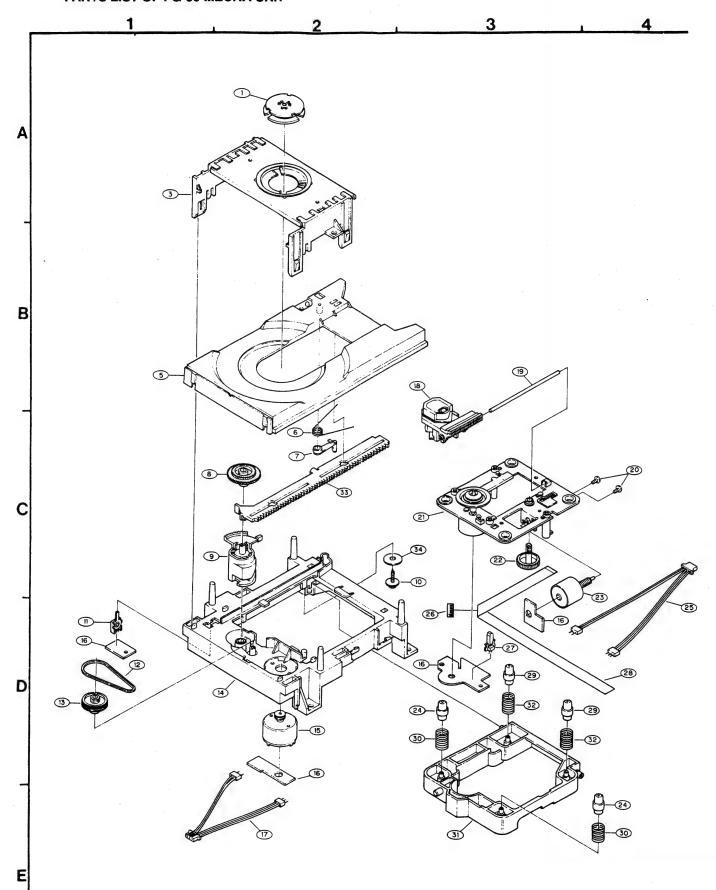
Ref. No.	Part No.	Part Name	Remarks	Q'ty
301	505 0061 010	ENVELOPE		1
302	511 2322 105	INST.MANUAL	U.S.A. Model	1
			U.K. Model	
			Multi-Voltage Model	
303	511 2347 106	INST.MANUAL	Canada And Europe Model	1
304	515 0474 002	DAI WARRANTY ROM	U.S.A. Model	1
305	515 0436 008	DCI WARRANTY	Canada Model	1
306	204 2518 008	8P MD.CORD		1
307	203 6305 007	2P PIN CORD		2
308	505 0102 092	STYRENE PAPER		1
309	505 0099 008	POLY COVER		1
310	505 0099 082	POLY COVER		1
311	412 3556 000	CONNECTING BRACKET		2
312	477 0053 040	WASHER		8
313	471 3505 021	SCREW 5×10		8
314	503 1001 206	CUSHION		2
315	RC-35	REMOTE CONTROL UNIT		1
316	505 1012 021	STYRENE PAPER		'
317	503 1012 021	CUSHION(RC)	Remote Control Unit	2
318	501 1527 137	CARTON CASE	Memore Countrol Clin	1
310	301 1327 137	CARTON CASE		l '
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PARTS LIST OF FG-50 MECHANISM UNIT

1 GEN 1396 Clamper Press	
I GENT 1000 CHAMPER FIESS	Sub Ass'y
 3 412 3133 006 Clamper Frame 	e
5 431 0300 302 Loader Frame	
6 463 0669 008 Lock Lever Spr	ring
7 412 3215 202 Lock Lever	
8 424 0162 005 Gear	
9 424 0160 104 Lift Cam	
10 477 0262 006 Special Screw	
11 212 1059 006 Open/Close SV 12 423 0056 011 Belt	Ν.
12 423 0056 011 Belt 13 424 0161 103 Pulley Gear	
14 411 1019 300 Mecha. Chassis	ic
15 GEN 1492 L. Motor Sub A	
16 222 2275 006 Motor SW. P.W	1
17 203 8302 008 5-3, 2P PH-SAI	
18 499 0191 009 Laser P.U	KSS-240A
19 443 1094 005 P.U. Shaft	
20 471 3801 039 2×3 CBS-Z	
21 GEN 1636 Spindle Motor A	Ass'y
22 424 0164 003 Helical Gear	
23 GEN 1397 Slide Motor Sul	b Ass'y
24 462 0078 104 Damper	
25 203 8301 009 5-3, 2P PH-SA	N CORD-W
26 443 1093 006 FFC Clamper	
27 212 6013 005 Inner SW. (PU))
28 009 0051 001 12P FFC	
29 462 0078 117 Damper	
30 463 0583 100 Spring (F) © 31 GEN 1408 Mecha, Frame	Sub Apply
 31 GEN 1408 Mecha. Frame 32 461 0661 000 Spring F. (R) 	Sub Ass y
33 435 0117 403 Slide Rack	
● 34 462 0113 014 Rubber Washe	r

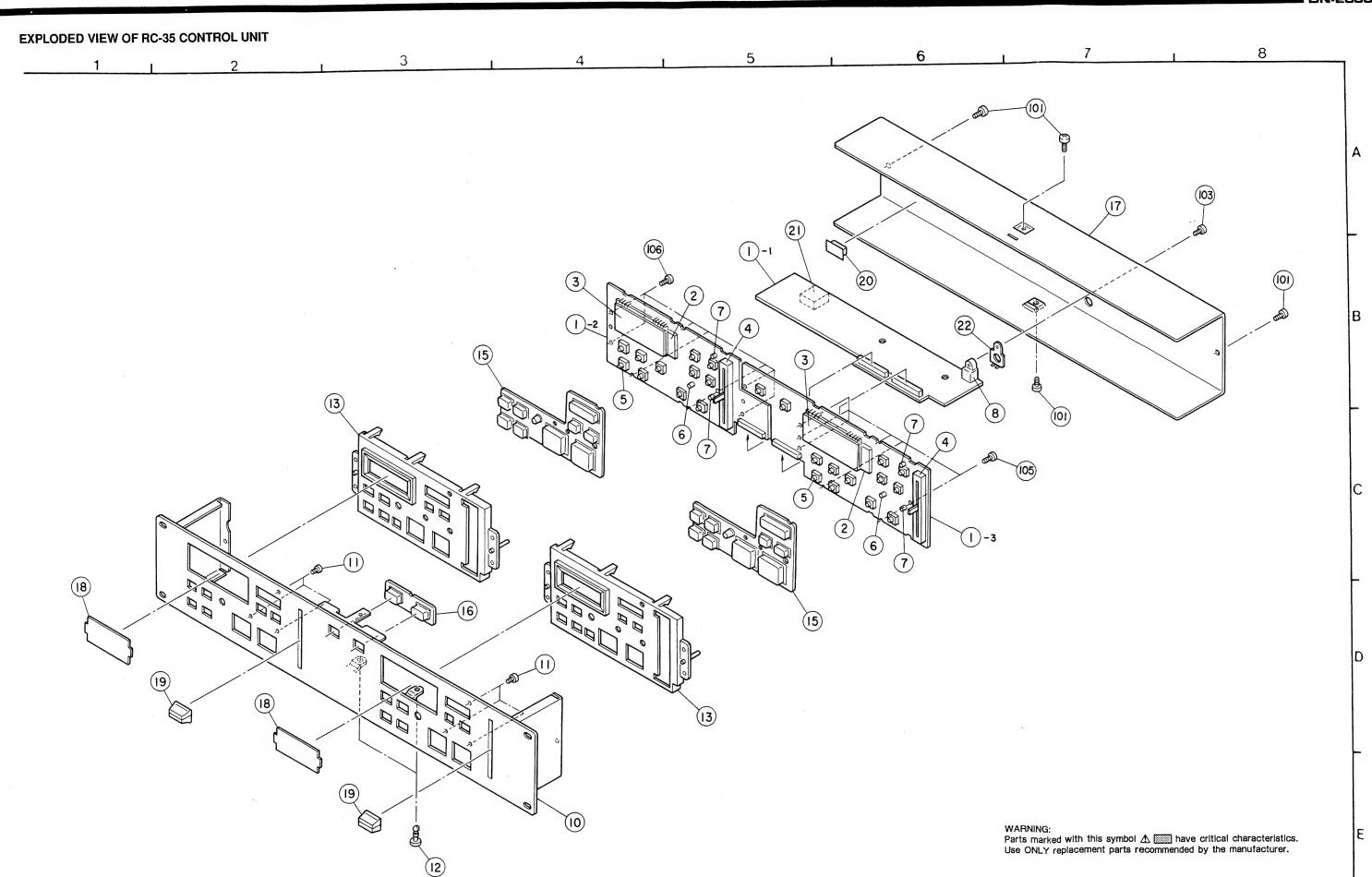
PARTS LIST OF FG-50 MECHA UNIT



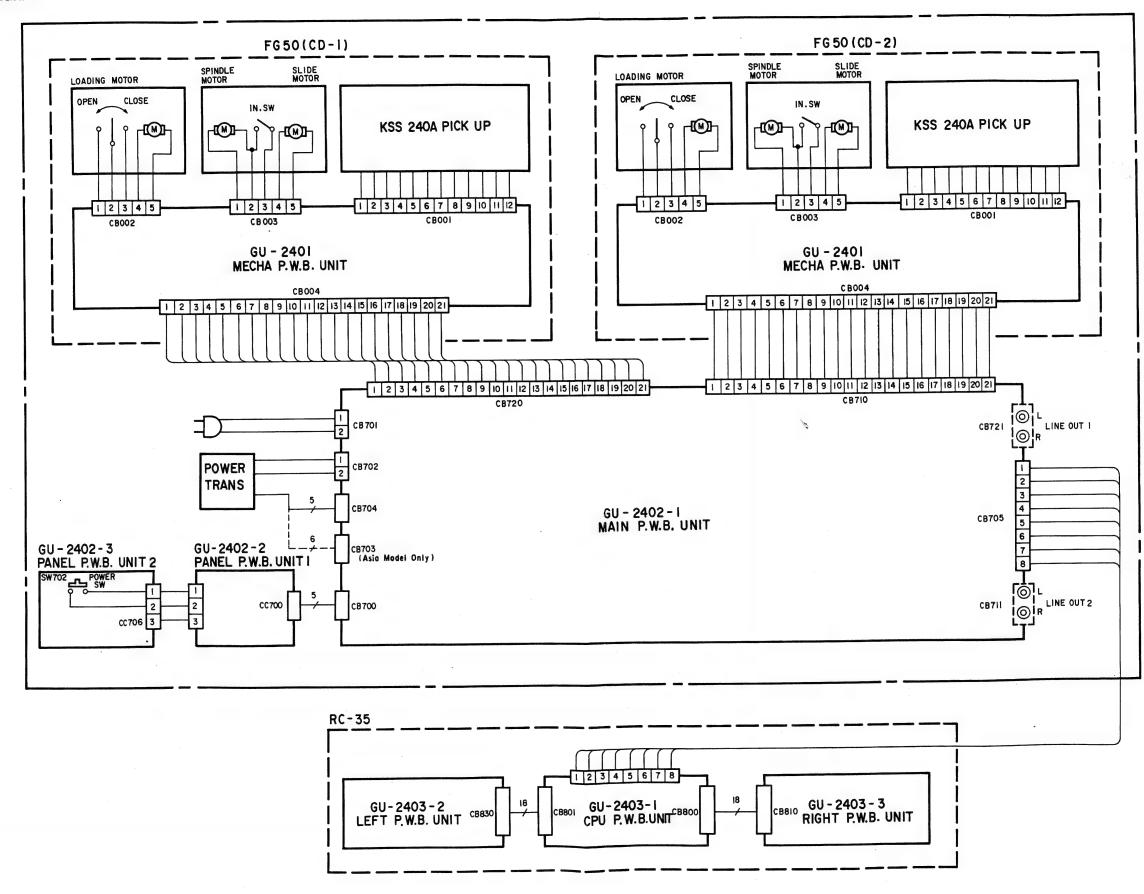
PART LIST OF RC-35 CONTROL UNIT

Ref. No.	Part No.	Part Name	Remarks	Q'ty
● 1	GU- 2403	CONTROL PWB UNIT		1
₋₁₋₁	GU- 2403 -1	CPU PWB UNIT		
4 1-2	GU- 2403 -2	LEFT PWB UNIT		
L ₁₋₃	GU- 2403 -3	RIGHT PWB UNIT		
2	393 9511 104	LED BACK LIGHT		1
3	393 4139 002	LCD		2
4	211 0763 015	SLIDE VOLUME		2
5	212 4763 904	TACT SWITCH(LONG ST)		24
6	393 9462 017	LED (RED)	SLR-40VC3F	2
7	393 9512 006	LED (GRN)	SLR-40MC	4
8	205 0717 008	8P MINI DIN CONN.BASE		1
9		50 500 T 54 UFL 400 V		
10	144 2191 107	RC FRONT PANEL ASS'Y		1
1110	146 1371 005	LED WINDOW		6
1210	449 0074 011	LOCKING CARD SPACER		2
13	146 1369 101	INNER PANEL		2
14 15	110 0000 100	DI IRRED RITTON (A)		2
15 16	119 0068 100 119 0069 109	RUBBER BUTTON (A) RUBBER BUTTON (B)		1
1017	105 1030 109	COVER		
1718	146 1370 200	WINDOW		2
19	113 1523 002	SLIDE KNOB		2
20	461 0653 005	CUSHION (M)		1
2021	461 0504 002	PAD PAD		1
2122	412 3555 108	EARTH PLATE		1
66				'
101	473 7015 005	TAPPING SCREW 3×6 (S)	ì	4
103	473 7508 017	TAPPING SCREW 3×10(P)	Black	1
105	473 7500 015	TAPPING SCREW 3×8 (P)		8
106	473 7002 021	TAPPING SCREW 3×8 (S)	Black	8
		*		
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 Part indicated with the mark " are not always in stock and possibly to take a long period of time for supplying, or in some case supplying of part may be refused.



WIRING DIAGRAM

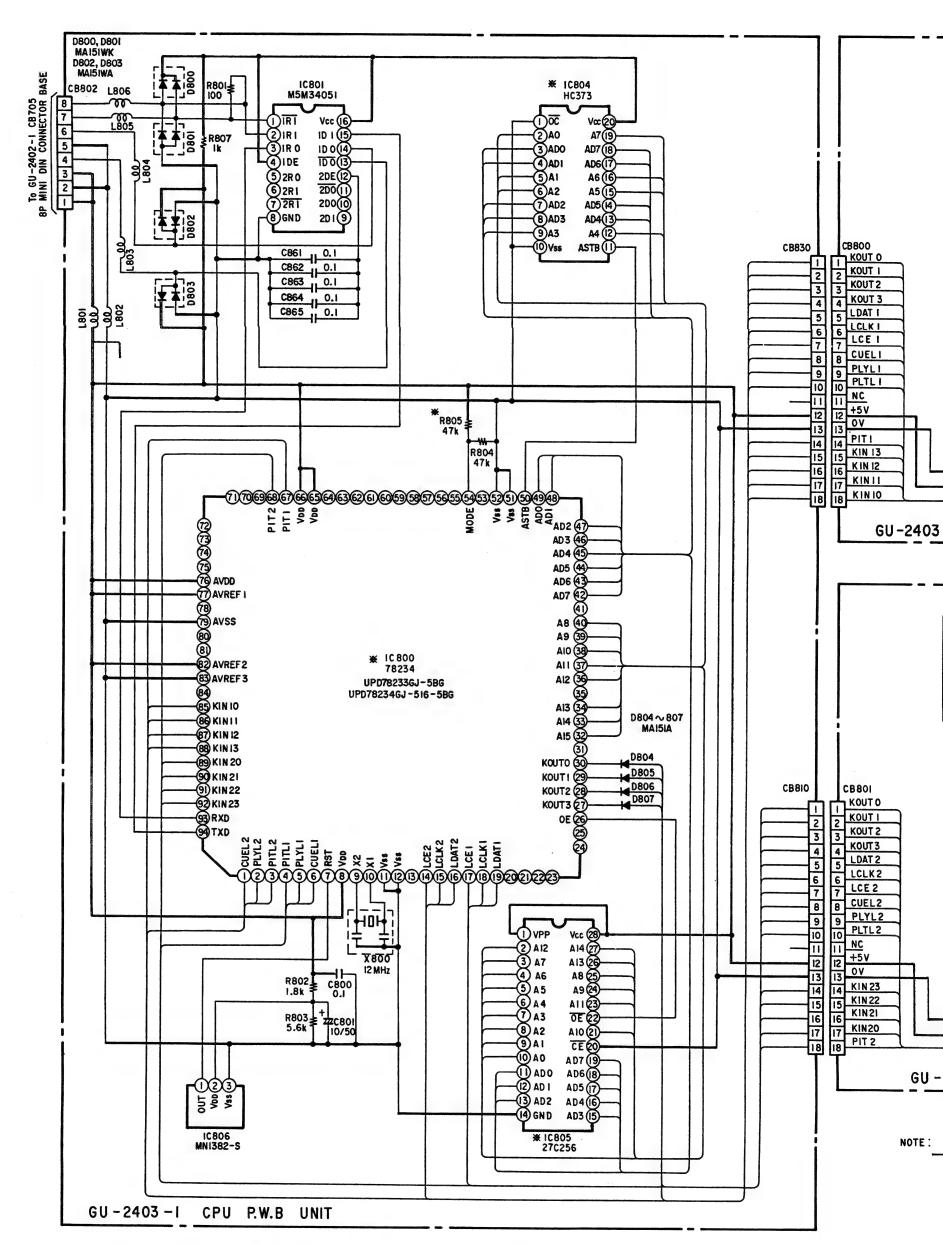


4

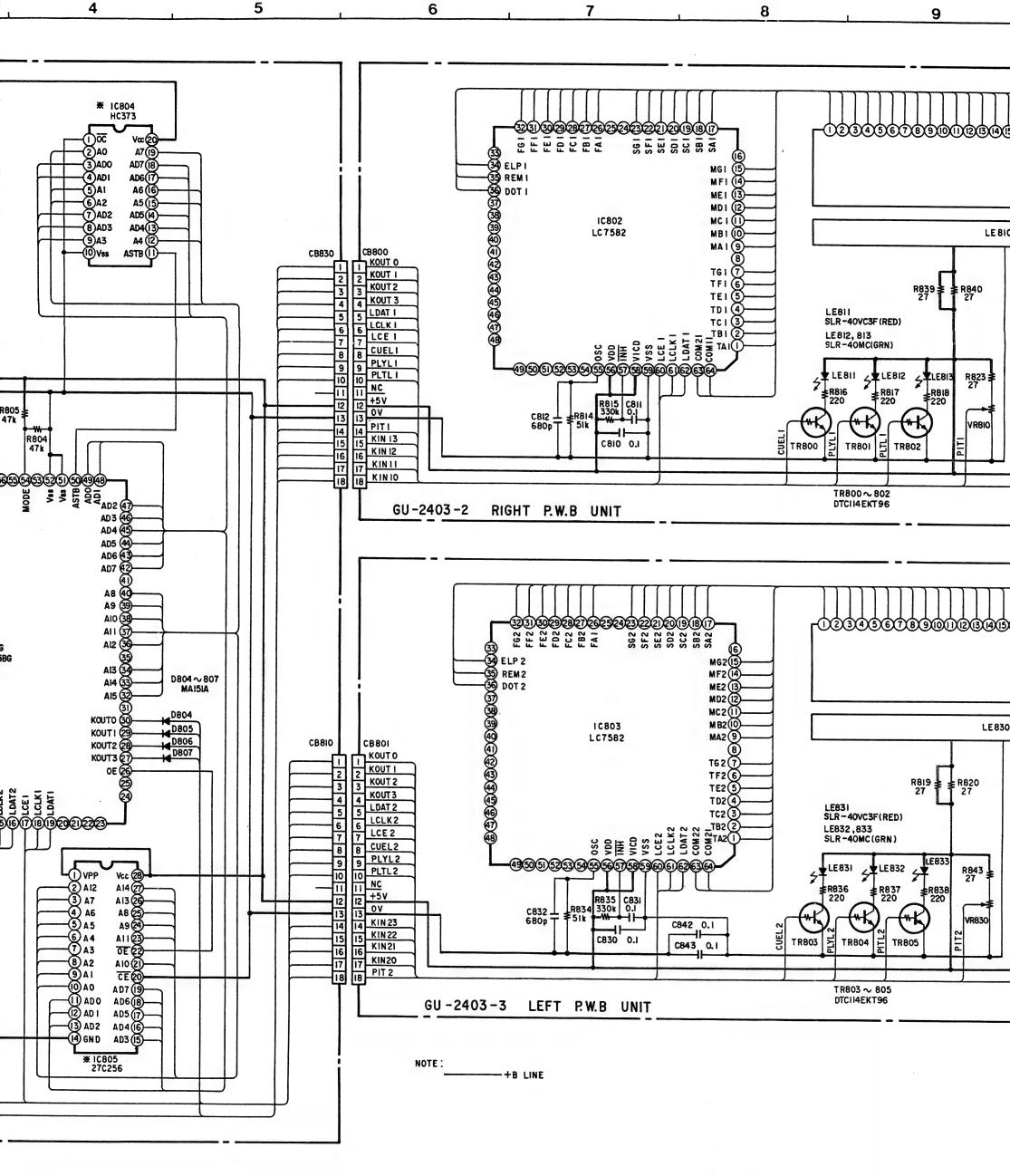
3

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^{*} For serial numbers of U.S.A. Model after No.621, of Europe Model up to No.882-885 and after No.951, of U.K. Model after No. 301, of Canada Model after No.131, and of Multi-Voltage Model after No.101, IC800 becomes UPD78234 GJ-516-5BG by CPU masking and makes IC804, IC805, R805 unnecessary.



up to No.882~885 and after No.951, of U.K. Model after el after No.101, IC800 becomes UPD78234 GJ-516-5BG by

NOTES ALL RESISTANCE VALUES IN OHM. k=1,000 OHM, M=1,000,000 OHM ALL CAPACITANCE VALUES IN MICRO FARAD. P=MICRO-MICRO FARAD EACH VOLTAGE AND CURRENT ARE MEASURED AT NO SIGNAL INPUT CONDITION. CIRCUIT AND PARTS ARE SUBJECT TO CHANGE WITHOUT PRIOR NOTICE.

WARNING:

Parts marked with this symbol Δ with the have critical characteristics. Use ONLY replacement parts recommended by the manufacturer.

Before returning the unit to the customer, make sure you make either (1) a k the leakage current exceeds 0.5 milliamps, or If the resistance from chassis defective.

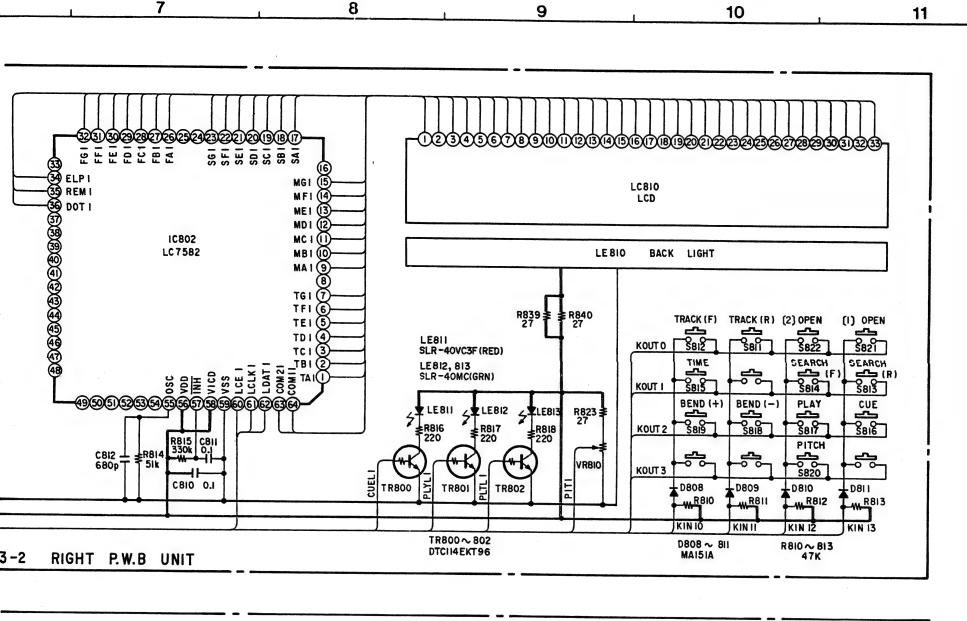
WARNING:

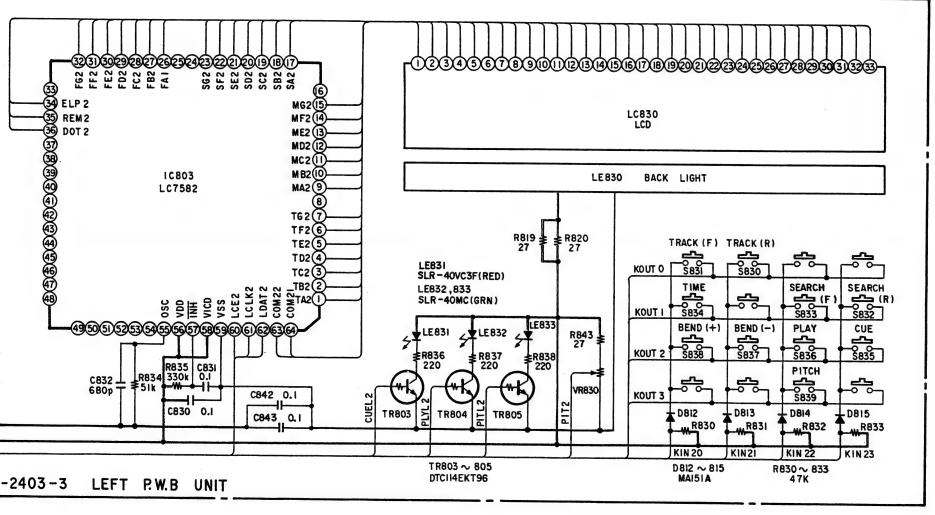
DO NOT return the unit to the customer until the problem is located and con NOTES:

Circuit and parts are subject to change without prior notice.

D

Ε





---+B LINE

WARNING:

Parts marked with this symbol Δ with the have critical characteristics.

Use ONLY replacement parts recommended by the manufacturer.

CAUTION:

Before returning the unit to the customer, make sure you make either (1) a leakage current check or (2) a line to chassis resistance check. If the leakage current exceeds 0.5 milliamps, or if the resistance from chassis to either side of the power cord is less than 240 kohms, the unit is defective.

WARNING:

DO NOT return the unit to the customer until the problem is located and corrected.

NOTES:

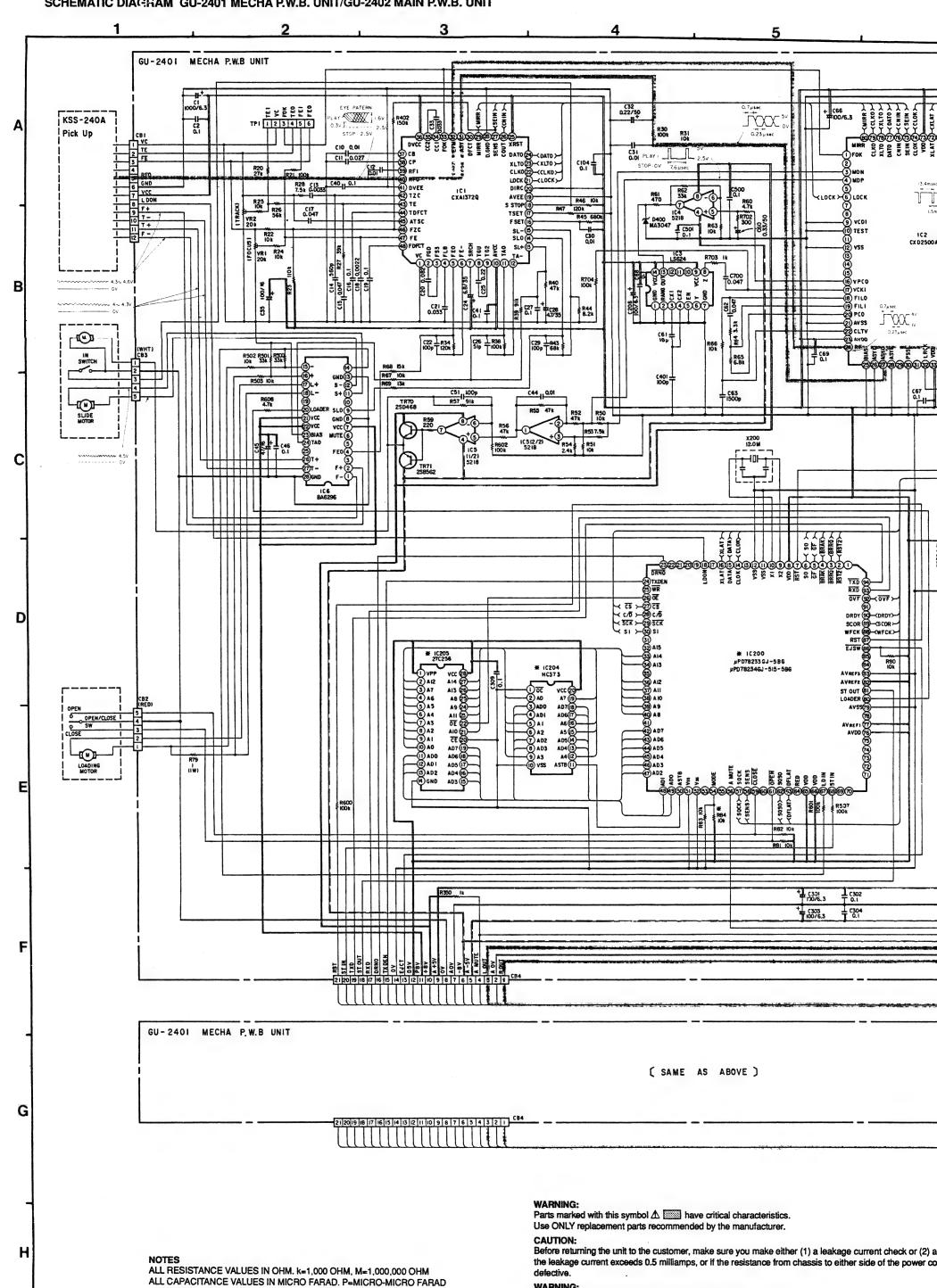
Circuit and parts are subject to change without prior notice.

OHM. k=1,000 OHM, M=1,000,000 OHM I MICRO FARAD. P=MICRO-MICRO FARAD IT ARE MEASURED AT NO SIGNAL INPUT CONDITION. IJECT TO CHANGE WITHOUT PRIOR NOTICE.

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SCHEMATIC DIAGRAM GU-2401 MECHA P.W.B. UNIT/GU-2402 MAIN P.W.B. UNIT



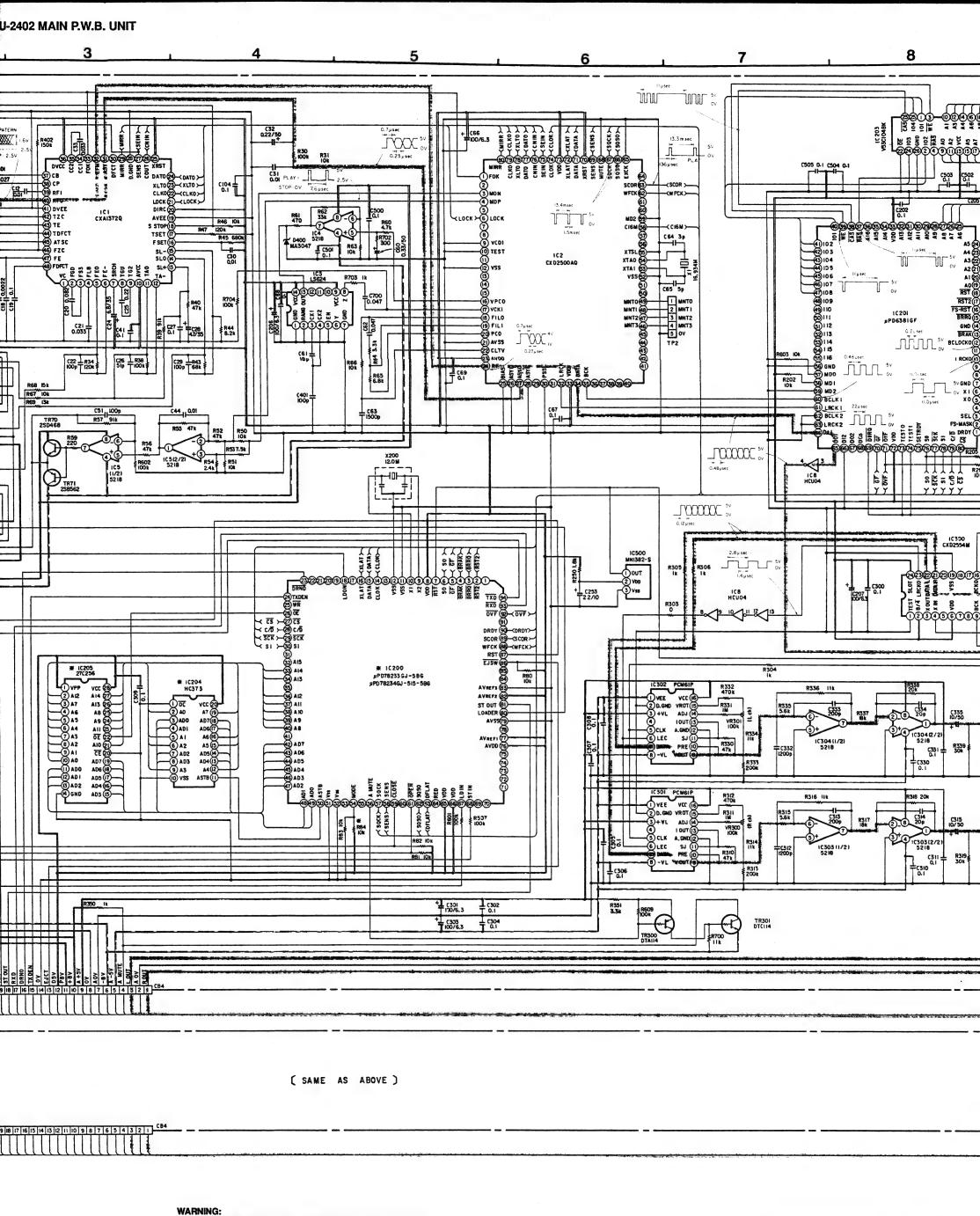
WARNING:

DO NOT return the unit to the customer until the problem is located and corrected.

Circuit and parts are subject to change without prior notice.

EACH VOLTAGE AND CURRENT ARE MEASURED AT NO SIGNAL INPUT CONDITION.

CIRCUIT AND PARTS ARE SUBJECT TO CHANGE WITHOUT PRIOR NOTICE.



M=1,000,000 OHM MICRO-MICRO FARAD AT NO SIGNAL INPUT CONDITION. WITHOUT PRIOR NOTICE.

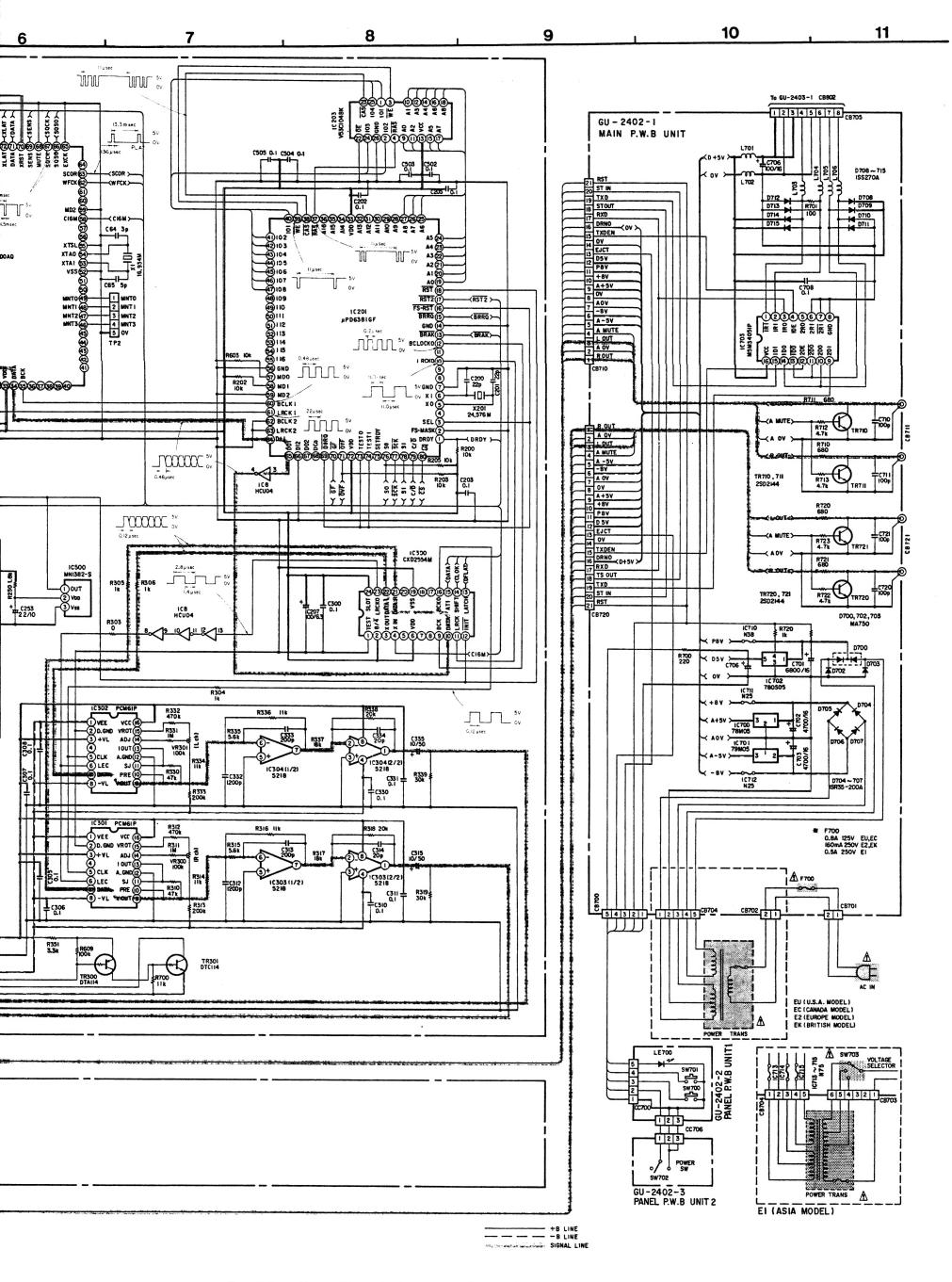
Parts marked with this symbol Δ and have critical characteristics. Use ONLY replacement parts recommended by the manufacturer.

Before returning the unit to the customer, make sure you make either (1) a leakage current check or (2) a line to chassis resistance check. If the leakage current exceeds 0.5 milliamps, or if the resistance from chassis to either side of the power cord is less than 240 kohms, the unit is defective.

WARNING:

DO NOT return the unit to the customer until the problem is located and corrected.

NOTES: Circuit and parts are subject to change without prior notice. * For serial numbers of U.S.A. Model after No. 6 No. 301, of Canada Model after No. 131, and o CPU masking and makes IC204, IC205, R84 u



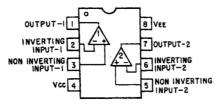
^{*} For serial numbers of U.S.A. Model after No. 621, of Europe Model up to No.882–885 and after No.951, of U.K. Model after No. 301, of Canada Model after No. 131, and of Multi-Voltage Model after No. 101, IC200 becomes UPD78234 GJ-515-5BG by CPU masking and makes IC204, IC205, R84 unnecessary.

SEMICONDUCTORS

IC'S

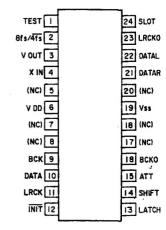
BA15218F (IC004,005,303,304)



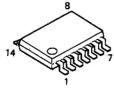


CXD2551MT (IC300)

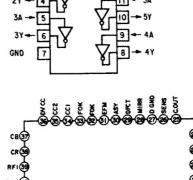
TC74HCU04AF



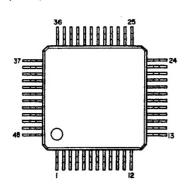
TC74HCUO4AF (IC008) SN74LS624NSR (IC003)

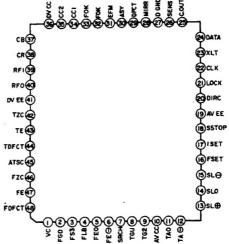




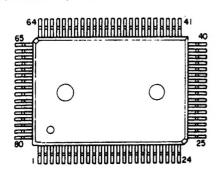


CXA1372Q (IC001)

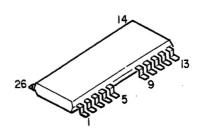




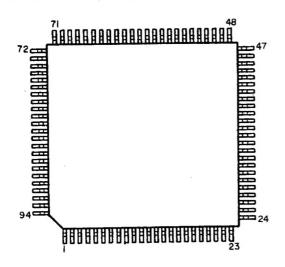
CXD2500AQ (IC002) UPD6381GF (IC201)



V53C104BK80 (IC203)

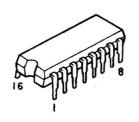


UPD78233GJ-5BG (IC200,800)

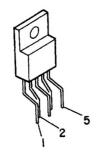


PCM61P-L (IC301,302)

M5M34051P (IC703)

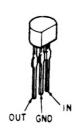


L780S05 (IC702)

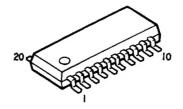


1. Vin 2. NC 3. GND

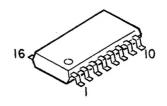
4. STB 5. Vout NJM78M05FA (IC700) NJM79M05FA (IC701)



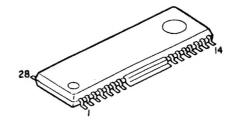
HD74HC373FP-TL (IC204,804)



M5M34051FP (IC801)



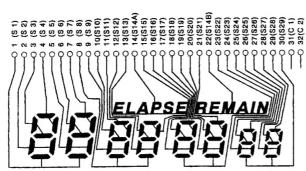
BA6296 FP-T1 (IC006)



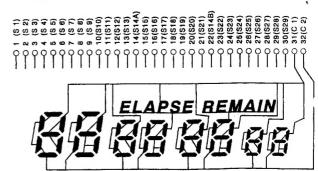
IC PROTECTOR ICP-N38T (IC710) ICP-N25T (IC711,712)



Segment

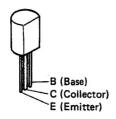


Common



TRANSISTORS

2SB562(C) (TR073) 2SD468(C) (TR072)



DTC114EK96 (TR300,301) (TR800~805)

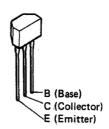


1: GND/Emitter

2: In/Base

3: Out/Collector

2SD2144STPU (TR710, 720 720,721)



DIODES

MA151A (D804 ~ 815) MA151WA (D802,803)



1 : Anode

2 : Cathode

3: Anode / Cathode



MA151WK (D800,801)



1 : Anode

2 : Cathode



MA3047-TX (D400)



1 : Anode

2:NC

3: Cathode



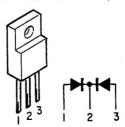
1SR35-200A (D704~707)



1SS270A TE (D708~715)

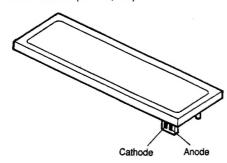


MA750 (D700,702,703)



LED

BACK LIGHT (LE810,830)



SLR-40VC3F (RED) (LE811,831) SLR-40MC3F (GRN) (LE812,813,832,833)

